

PMS152 8bit OTP Type SuLED IO Controller Datasheet

Version 1.05 - June 9, 2020

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Table of content

1.	reatu	ires	9
	1.1.	Special Features	9
	1.2.	System Features	9
	1.3.	CPU Features	9
	1.4.	Package Information	9
2.	Gene	eral Description and Block Diagram	10
3.	Pin D	Definition and Functional Description	11
4.	Devic	ce Characteristics	17
	4.1.	AC/DC Device Characteristics	17
	4.2.	Absolute Maximum Ratings	18
	4.3.	Typical ILRC frequency vs. VDD	19
	4.4.	Typical IHRC frequency deviation vs. VDD(calibrated to 16MHz)	19
	4.5.	Typical ILRC Frequency vs. Temperature	20
	4.6.	Typical IHRC Frequency vs. Temperature (calibrated to 16MHz)	20
	4.7.	Typical operating current vs. VDD @ system clock = ILRC/n	21
	4.8.	Typical operating current vs. VDD @ system clock = IHRC/n	21
	4.9.	Typical operating current vs. VDD @ system clock = 4MHz EOSC / n	22
	4.10.	Typical operating current vs. VDD @ system clock = 32KHz EOSC / n	22
	4.11.	Typical operating current vs. VDD @ system clock = 1MHz EOSC / n	23
	4.12.	Typical IO driving current (I _{OH}) and sink current (I _{OL})	23
	4.13.	Typical IO input high/low threshold voltage (V_{IH}/V_{IL})	24
	4.14.	Typical resistance of IO pull high device	25
	4.15.	Typical power down current (I _{PD}) and power save current (I _{PS})	25
5.	Func	tional Description	27
	5.1.	Program Memory - OTP	27
	5.2.	Boot Procedure	27
		5.2.1. Timing charts for reset conditions	28
	5.3.	Data Memory - SRAM	29
	5.4.	Oscillator and Clock	29
		5.4.1. Internal High RC oscillator and Internal Low RC oscillator	29
		5.4.2. Chip calibration	29
		5.4.3. IHRC Frequency Calibration and System Clock	30



		5.4.4. External Crystal Oscillator	31
		5.4.5. System Clock and LVR level	33
		5.4.6. System Clock Switching	34
	5.5.	Comparator	35
		5.5.1 Internal reference voltage (V _{internal R})	36
		5.5.2 Using the comparator	38
		5.5.3 Using the comparator and band-gap 1.20V	39
	5.6	16-bit Timer (Timer16)	40
	5.7	8-bit Timer (Timer2) with PWM generation	42
		5.7.1 Using the Timer2 to generate periodical waveform	43
		5.7.2 Using the Timer2 to generate 8-bit PWM waveform	45
		5.7.3 Using the Timer2 to generate 6-bit PWM waveform	46
	5.8	11-bit PWM Generators	47
		5.8.1 PWM Waveform	47
		5.8.2 Hardware Diagram	48
		5.8.3 Equations for 11-bit PWM Generator	49
		5.8.4 PWM Waveforms with Complementary Dead Zones	49
	5.9	WatchDog Timer	52
	5.10	. Interrupt	53
	5.11	. Power-Save and Power-Down	55
		5.11.1 Power-Save mode ("stopexe")	55
		5.11.2 Power-Down mode ("stopsys")	56
		5.11.3 Wake-up	56
	5.12	IO Pins	58
	5.13	Reset and LVR	59
		5.13.1 Reset	59
		5.13.2 LVR reset	59
6	IO Re	egisters	60
٥.			
	6.1.	ACC Status Flag Register (<i>flag</i>), IO address = 0x00	
	6.2.	Stack Pointer Register (sp), IO address = 0x02	
	6.3.	Clock Mode Register (clkmd), IO address = 0x03	
	6.4.	Interrupt Enable Register (<i>inten</i>), IO address = 0x04	
	6.5.	Interrupt Request Register (intrq), IO address = 0x05	
	6.6.	Timer16 mode Register (<i>t16m</i>), IO address = 0x06	
	6.7.	MISC Register (<i>misc</i>), IO address = 0x08	
	6.8.	External Oscillator setting Register (eoscr), IO address = 0x0a	
	6.9.	Interrupt Edge Select Register (integs), IO address = 0x0c	63



	6.10.	Port A Digital Input Enable Register (<i>padier</i>), IO address = 0x0d	63
	6.11.	Port B Digital Input Enable Register (pbdier), IO address = 0x0e	64
	6.12.	Port A Data Register (pa), IO address = 0x10	64
	6.13.	Port A Control Register (pac), IO address = 0x11	64
	6.14.	Port A Pull-High Register (paph), IO address = 0x12	64
	6.15.	Port B Data Register (pb), IO address = 0x14	64
	6.16.	Port B Control Register (pbc), IO address = 0x15	64
	6.17.	Port B Pull-High Register (pbph), IO address = 0x16	65
	6.18.	Comparator Control Register (<i>gpcc</i>), IO address = 0x18	65
	6.19.	Comparator Selection Register (<i>gpcs</i>), IO address = 0x19	65
	6.20.	Timer2 Control Register (tm2c), IO address = 0x1c	66
	6.21.	Timer2 Scalar Register (tm2s), IO address = 0x17	66
	6.22.	Timer2 Counter Register (tm2ct), IO address = 0x1d	67
	6.23.	Timer2 Bound Register (tm2b), IO address = 0x09	67
	6.24.	PWMG0 control Register (pwmg0c), IO address = 0x20	67
	6.25.	PWMG Clock Register (pwmgclk), IO address = 0x21	68
	6.26.	PWMG0 Duty Value High Register (pwmg0dth), IO address = 0x22	68
	6.27.	PWMG0 Duty Value Low Register (pwmg0dtl), IO address = 0x23	68
	6.28.	PWMG Counter Upper Bound High Register (pwmgcubh), IO address = 0x24	68
	6.29.	PWMG Counter Upper Bound Low Register (pwmgcubl), IO address = 0x25	68
	6.30.	PWMG1 control Register (pwmg1c), IO address = 0x26	69
	6.31.	PWMG1 Duty Value High Register (pwmg1dth), IO address = 0x28	69
	6.32.	PWMG1 Duty Value Low Register (pwmg1dtl), IO address = 0x29	69
	6.33.	PWMG2 control Register (pwmg2c), IO address = 0x2C	70
	6.34.	PWMG2 Duty Value High Register (pwmg2dth), IO address = 0x2E	70
	6.35.	PWMG2 Duty Value Low Register (pwmg2dtl), IO address = 0x2F	70
7.	Instru	ıctions	71
	7.1.	Data Transfer Instructions	72
	7.2.	Arithmetic Operation Instructions	
	7.3.	Shift Operation Instructions	
	7.4.	Logic Operation Instructions	
	7.5.	Bit Operation Instructions	
	7.6.	Conditional Operation Instructions	
	7.7.	System control Instructions	
	7.8.	Summary of Instructions Execution Cycle	
	7.9.	Summary of affected flags by Instructions	
	7.10.	BIT definition	



8.	3. Code Options							
9.	Special Notes							
	9.1.	Warnir	ng	87				
	9.2.		IC					
		_	IO pin usage and setting					
			Interrupt					
		9.2.3.	System clock switching	88				
		9.2.4.	Watchdog	88				
		9.2.5.	TIMER time out	89				
		9.2.6.	IHRC	89				
		9.2.7.	LVR	89				
		9.2.8.	Programming Writing	89				
	9.3	Using	ICF	91				



Revision History:

Revision	Date	Description
0.01	2017/07/21	1 st version
0.02	2018/01/24	 Delete Section 4.16 Timing charts for boot up conditions Amend Section 5.1. Program Memory – OTP Add Section 5.2.1 Timing charts for reset conditions Amend Table 2: Three oscillation circuits Amend Section 5.4.3. IHRC Frequency Calibration and System Clock Amend Section 5.4.4. External Crystal Oscillator Amend Section 5.4.5. System Clock and LVR level Amend Fig.3: Options of System Clock Amend Section 5.5.2. Using the comparator Amend Section 5.5.3 Using the comparator and band-gap 1.20V Amend Section 5.10 Interrupt Amend Section 5.11.1 Power-Save mode Amend Section 5.11.2 Power-Down mode Amend Section 5.11.3 Wake-up Amend Section 6.3. Clock Mode Register Amend Section 6.7 MISC Register
		 31. Amend Section 6.10. Port A Digital Input Enable Register 32. Amend Section 6.11. Port B Digital Input Enable Register 33. Delete Section 6.13. MISC2 Register 34. Amend Section 6.14. Port A Pull-High Register 35. Amend Section 6.19. Comparator Selection Register. 36. Amend Section 6.20. Timer2 Control Register 37. Amend Section 6.21. Timer2 Scalar Register 38. Delete the Symbol "pc0" in Chapter 7 39. Amend Chapter 8 Code Options 40. Amend Section 9.2.1. IO pin usage and setting 41. Amend Section 9.2.9 BIT definition 43. Amend Section 9.2.10. Programming Writing 44. Amend Section 9.3. Using ICE



		Amend Section 1.1 Special Features
		2. Open 32KHz EOSC mode
		3. Amend Section 5.4.4 External Crystal Oscillator
		4. Amend Section 5.7 8-bit Timer (Timer2) with PWM generation
		5. Add Fig.12: Comparator controls the output of PWM waveform
		6. Amend Section 5.8.3 Equations for 11-bit PWM Generator
		7. Amend Section 5.10 Interrupt
		8. Amend Section 5.11.1 Power-Save mode
1.03	2018/11/13	9. Amend Table 6: Differences in wake-up sources between Power-Save mode and
		Power-Down mode
		10. Amend Section 6.29 PWMG Counter Upper Bound Low Register
		11. Amend Section 7.8 Summary of Instructions Execution Cycle and delete 9.2.8
		12. Move Section 9.2.9 BIT definition to Section 7.10
		13. Updated the link in Section 9.1
		14. Amend Section 9.2.5 TIMER time out
		15. Amend Section 9.2.8 Programming Writing
		16. Amend Section 9.3 Using ICE
		Amend Section 1.2 System Features
		2. Amend SOP14 Pin Definition and Functional Description
		3. Amend Section 4.1 and 4.6
		4. Amend Section 5.2.1 Timing charts for reset conditions
		5. Amend Section 5.7, 5.7.1, 5.7.2, 5.7.3
1.04	2019/10/17	6. Amend Section 5.8.3 Equations for 11-bit PWM Generator
		7. Add Section 5.8.4 PWM Waveforms with Complementary Dead Zones
		8. Amend Section 5.11.1, 5.11.2, 5.11.3
		9. Amend Section 6.3 , 6.10, 6.11,
		10. Amend Chapter 8 Code Options
		11. Amend Section 9.2.8 Programming Writing
4.05	0000/00/00	1. Amend 4.1 AC/DC Device Characteristics: t _{WUP} , t _{SBP}
1.05	2020/06/09	2. Amend Chapter 8
		3. Amend 5.4.6, 5.8, 5.8.3, 5.12, 5.13.2, 6.18, 9.3



1. Features

1.1. Special Features

- ◆ General purpose series
- Not supposed to use in AC RC step-down powered or high EFT requirement applications.
 PADAUK assumes no liability if such kind of applications can not pass the safety regulation tests.
- ◆ Operating temperature range: -20°C ~ 70°C

1.2. System Features

- 1.25KW OTP program memory
- 80 Bytes data RAM
- One hardware 16-bit timer
- ◆ One hardware 8-bit timers with 6/7/8-bit PWM generation
- ◆ One set triple 11bit SuLED (Super LED) PWM generators and timers
- One hardware comparator
- ◆ 14 IO pins with optional pull-high resistor
- Three different IO Driving capability group to meet different application requirements
 - (1) PB3, PB5, PB7 Drive/ Sink Current= 7mA/30mA
 - (2) Other IOs (except PA5) Drive/ Sink Current = 7mA/14mA
 - (3) PA5 Sink Current = 4mA
- ◆ Every IO pin can be configured to enable wake-up function
- ◆ Clock sources: IHRC, ILRC & EOSC(XTAL mode)
- ◆ For every wake-up enabled IO, two optional wake-up speed are supported: normal and fast
- ◆ Eight levels of LVR: 4.5V, 3.5V, 3.0V, 2.7V, 2.5V, 2.2V, 2.0V and 1.8V
- ◆ Two selectable external interrupt pins: PA0/PB5, PB0/PA4
- ◆ Band-gap circuit to provide 1.20V reference voltage

1.3. CPU Features

- One processing unit operating mode
- ♦ 86 powerful instructions
- Most instructions are 1T execution cycle
- ◆ Programmable stack pointer to provide adjustable stack level
- Direct and indirect addressing modes for data access. Data memories are available for use as an index pointer of Indirect addressing mode
- IO space and memory space are independent

1.4. Package Information

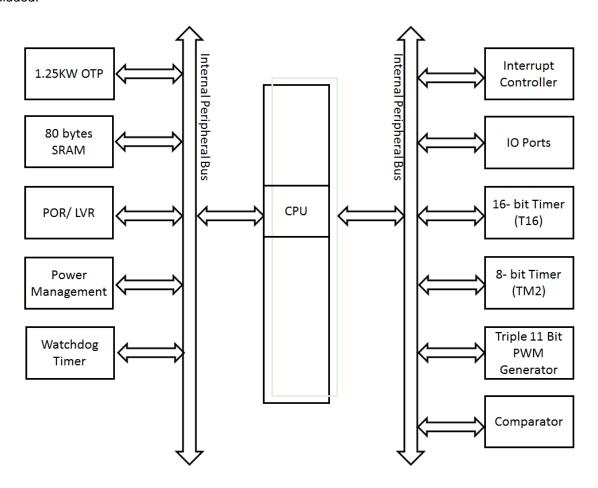
- ◆ PMS152-S16: SOP16 (150mil)
- ◆ PMS152-1J16A: QFN3*3-16pin (0.5mm pitch)
- PMS152-S14: SOP14 (150mil)
- ◆ PMS152-M10: MSOP10 (118mil)
- PMS152-S08: SOP8 (150mil)
- ◆ PMS152-U06: SOT23-6 (60mil)



2. General Description and Block Diagram

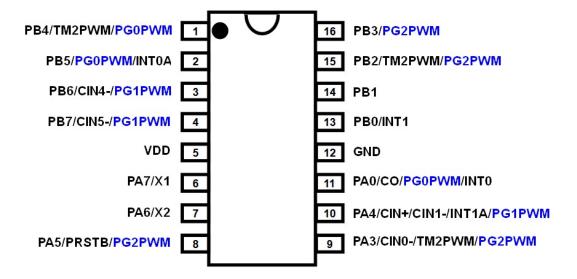
The PMS152 family is an IO-Type, fully static, OTP-based CMOS 8-bit microcontroller. It employs RISC architecture and all the instructions are executed in one cycle except that some instructions are two cycles that handle indirect memory access.

1.25KW bits OTP program memory and 80 bytes data SRAM are inside, one hardware comparator is built inside the chip to compare signal between two pin or with either internal reference voltage V_{internalR} or internal band-gap reference voltage. PMS152 also provides three hardware timers: one 16-bit timer, one 8-bit timer with PWM generation, and one new triple 11-bit timer with SuLED PWM generation (PWMG0, PWMG1 & PWMG2) are included.

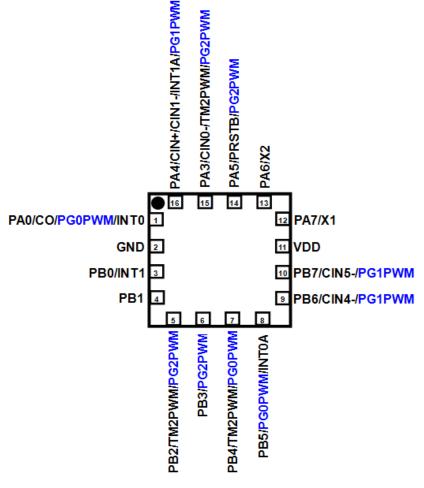




3. Pin Definition and Functional Description

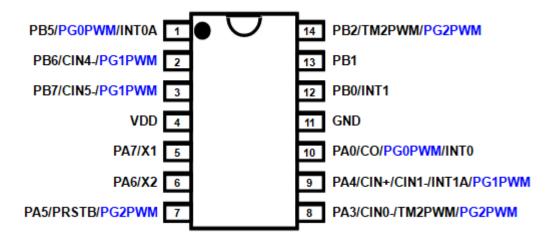


PMS152-S16 (SOP16-150mil)

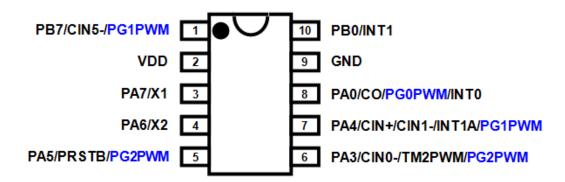


PMS152-1J16A (QFN3*3-16P-0.5pitch)

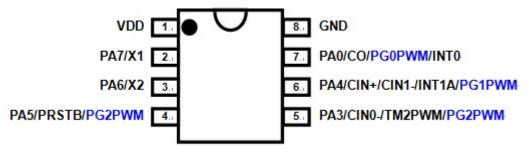




PMS152-S14 (SOP14-150mil)

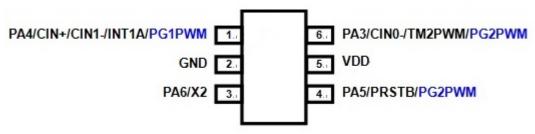


PMS152-M10 (MSOP10-118mil)



PMS152-S08 (SOP8-150mil)





PMS152-U06 (SOT23-6 60mil)

Pin Name	Pin Type & Buffer Type	Description
PA7 / X1	IO ST / CMOS	 The functions of this pin can be: (1) Bit 7 of port A. It can be configured as digital input or two-state output, with pull-high resistor. (2) X1 is Crystal XIN when crystal oscillator is used. If this pin is used for crystal oscillator, bit 7 of <i>padier</i> register must be programmed "0" to avoid leakage current. This pin can be used to wake-up system during sleep mode; however, wake-up function is also disabled if bit 7 of <i>padier</i> register is "0".
PA6 / X2	IO ST / CMOS	The functions of this pin can be: (1) Bit 6 of port A. It can be configured as digital input or two-state output, with pull-high resistor. (2) X2 is Crystal XOUT when crystal oscillator is used. If this pin is used for crystal oscillator, bit 6 of <i>padier</i> register must be programmed "0" to avoid leakage current. This pin can be used to wake-up system during sleep mode; however, wake-up function is also disabled if bit 6 of <i>padier</i> register is "0".
PA5 / PRSTB / PG2PWM	IO (OD) ST / CMOS	 The functions of this pin can be: (1) Bit 5 of port A. It can be configured as digital input or open-drain output, with pull-high resistor. (2) Hardware reset. (3) Output of 11-bit PWM generator PWMG2. This pin can be used to wake-up system during sleep mode; however, wake-up function is also disabled if bit 5 of <i>padier</i> register is "0". <u>Please put 33Ω resistor in series to have high noise immunity when this pin is in input mode.</u>



Pin Name	Pin Type & Buffer Type	Description
PA4 / CIN+ / CIN1- / INT1A / PG1PWM	IO ST / CMOS / Analog	 The functions of this pin can be: (1) Bit 4 of port A. It can be configured as digital input or two-state output, with pull-high resistor. (2) Plus input source of comparator. (3) Minus input source 1 of comparator. (4) External interrupt line 1A. It can be used as an external interrupt line 1. Both rising edge and falling edge are accepted to request interrupt service and configurable by register setting (5) Output of 11-bit PWM generator PWMG1. When this pin is configured as analog input, please use bit 4 of register padier to disable the digital input to prevent current leakage. The bit 4 of padier register can be set to "0" to disable digital input; wake-up from power-down by toggling this pin is also disabled.
PA3 / CIN0- / TM2PWM / PG2PWM	IO ST / CMOS / Analog	The functions of this pin can be: (1) Bit 3 of port A. It can be configured as digital input or two-state output, with pull-high resistor. (2) Minus input source 0 of comparator. (3) PWM output from Timer2 (4) Output of 11-bit PWM generator PWMG2 When this pin is configured as analog input, please use bit 3 of register <i>padier</i> to disable the digital input to prevent current leakage. The bit 3 of <i>padier</i> register can be set to "0" to disable digital input; wake-up from power-down by toggling this pin is also disabled.
PA0 / CO / PG0PWM / INT0	IO ST / CMOS	 The functions of this pin can be: (1) Bit 0 of port A. It can be configured as digital input or two-state output, with pull-high resistor. (2) Output of comparator. (3) Output of 11-bit PWM generator PWMG0. (4) External interrupt line 0. It can be used as an external interrupt line 0. Both rising edge and falling edge are accepted to request interrupt service and configurable by register setting The bit 0 of <i>padier</i> register can be set to "0" to disable wake-up from power-down by toggling this pin.
PB7 / CIN5- / PG1PWM	IO ST / CMOS / Analog	 The functions of this pin can be: (1) Bit 7 of port B. It can be configured as digital input or two-state output, with pull-high resistor. (2) Minus input source 5 of comparator. (3) Output of 11-bit PWM generator PWMG1. When this pin is configured as analog input, please use bit 7 of register <i>pbdier</i> to disable the digital input to prevent current leakage. The bit 7 of <i>pbdier</i> register can be set to "0" to disable digital input; wake-up from power-down by toggling this pin is also disabled.



Pin Name	Pin Type & Buffer Type	Description			
PB6 / CIN4- / PG1PWM	IO ST / CMOS / Analog	 The functions of this pin can be: (1) Bit 6 of port B. It can be configured digital input or two-state output, with pull-high resistor. (2) Minus input source 4 of comparator. (3) Output of 11-bit PWM generator PWMG1. When this pin is configured as analog input, please use bit 6 of register <i>pbdier</i> to disable the digital input to prevent current leakage. The bit 6 of <i>pbdier</i> register can be set to "0" to disable digital input; wake-up from power-down by toggling this pin is also disabled. 			
PB5 / PG0PWM / INT0A	IO ST / CMOS	 The functions of this pin can be: (1) Bit 5 of port B. It can be configured as digital input or two-state output, with pull-high resistor. (2) Output of 11-bit PWM generator PWMG0. (3) External interrupt line 0A. It can be used as an external interrupt line 0. Both rising edge and falling edge are accepted to request interrupt service and configurable by register setting. The bit 5 of <i>pbdier</i> register can be set to "0" to disable digital input; wake-up from power-down by toggling this pin is also disabled. 			
PB4 / TM2PWM / PG0PWM	IO ST / CMOS	 The functions of this pin can be: (1) Bit 4 of port B. It can be configured as digital input or two-state output, with pull-high resistor. (2) PWM output from Timer2 (3) Output of 11-bit PWM generator PWMG0. The bit 4 of <i>pbdier</i> register can be set to "0" to disable digital input; wake-up from power-down by toggling this pin is also disabled. 			
PB3 / PG2PWM	IO ST / CMOS	The functions of this pin can be: (1) Bit 3 of port B. It can be configured as digital input or two-state output, with pull-high resistor. (2) Output of 11-bit PWM generator PWMG2 The bit 3 of <i>pbdier</i> register can be set to "0" to disable digital input; wake-up from power-down by toggling this pin is also disabled.			
PB2 / TM2PWM / PG2PWM	IO ST / CMOS	 The functions of this pin can be: (1) Bit 2 of port B. It can be configured as digital input or two-state output, with pull-high resistor. (2) PWM output from Timer2 (3) Output of 11-bit PWM generator PWMG2 The bit 2 of <i>pbdier</i> register can be set to "0" to disable digital input; wake-up from power-down by toggling this pin is also disabled. 			



Pin Name	Pin Type & Buffer Type	Description			
PB1	IO ST / CMOS	The functions of this pin can be: Bit 1 of port B. It can be configured as digital input or two-state output, with pull-high resistor. The bit 1 of <i>pbdier</i> register can be set to "0" to disable digital input; wake-up from power-down by toggling this pin is also disabled.			
PB0 / INT1	IO ST / CMOS	 The functions of this pin can be: (1) Bit 0 of port B. It can be configured as digital input or two-state output, with pull-high resistor. (2) External interrupt line 1. It can be used as an external interrupt line 1. Both rising edge and falling edge are accepted to request interrupt service and configurable by register setting. If bit 0 of <i>pbdier</i> register is set to "0" to disable digital input, wake-up from power-down by toggling this pin is also disabled. 			
VDD	VDD	Positive power			
GND	GND	Ground			

Notes: IO: Input/Output; ST: Schmitt Trigger input; OD: Open Drain; Analog: Analog input pin

CMOS: CMOS voltage level



4. Device Characteristics

4.1. AC/DC Device Characteristics

All data are acquired under the conditions of Ta= -20 $^{\circ}$ C ~ 70 $^{\circ}$ C, V_{DD}=5.0V, f_{SYS} =2MHz unless noted.

Symbol	Description	Min	Тур	Max	Unit	Conditions (Ta=25°C)		
V _{DD}	Operating Voltage	1.8*	5.0	5.5	V	* Subject to LVR tolerance		
LVR%	Low Voltage Reset Tolerance	-5		5	%			
	System clock (CLK)* =							
	IHRC/2	0		8M		$V_{DD} \ge 3.5V$		
f _{SYS}	IHRC/4	0		4M	Hz	$V_{DD} \ge 2.5V$		
	IHRC/8	0		2M		$V_{DD} \ge 1.8V$		
	ILRC		55K			$V_{DD} = 3.0V$		
V_{POR}	Power On Reset Voltage		1.8*		V	* Subject to LVR tolerance		
1	Operating Current		1		mΑ	f _{SYS} =IHRC/16=1MIPS@5.0V		
I _{OP}	Operating Current		15		uA	f _{SYS} =ILRC=55KHz@3.3V		
I _{PD}	Power Down Current		1		uA	f_{SYS} = 0Hz, V_{DD} =5.0V		
טפי	(by stopsys command)		0.6		uA	f_{SYS} = 0Hz, V_{DD} =3.3V		
I _{PS}	Power Save Current		5		uA	V_{DD} =5.0V; f_{SYS} = ILRC		
13	(by stopexe command)					Only ILRC module is enabled.		
V _{IL}	Input low voltage for IO lines	0		0.1 V _{DD}	V			
	Input high voltage for IO lines	0.8 V _{DD}		V_{DD}	V	PA5		
V _{IH}		0.7 V _{DD}		V_{DD}		Others IO		
	IO lines sink current							
	PA7, PA6, PA4, PA3, PA0		14					
I _{OL}	PB6, PB4, PB2, PB1, PB0		14					
OL.	PB7, PB5, PB3		30		mA	V_{DD} =5.0V, V_{OL} =0.5V		
	PA5		4					
		IC) lines driv	e current				
	PA5		0					
la	PA7, PA6, PA4, PA3, PA0		-7					
I _{OH}	PB7, PB6, PB5, PB4, PB3		-7		mA	V _{DD} =5.0V, V _{OH} =4.5V		
	PB2, PB1, PB0		-7					
V _{IN}	Input voltage	-0.3	,	V _{DD} +0.3	V			
		0.0				V 10.3>V > 0.3		
I _{INJ (PIN)}	Injected current on pin			1	mA	V _{DD} +0.3 ≥ V _{IN} ≥ -0.3		
R _{PH}	Pull-high Resistance		100		ΚΩ	V _{DD} =5.0V		
	3		200			V _{DD} =3.0V		
V_{BG}	Band-gap Reference Voltage	1.145*	1.20*	1.255*	V	V _{DD} =2.2V ~ 5.5V		
- 60					•	-20°C <ta<70°c*< td=""></ta<70°c*<>		
		15.76*	16*	16.24*		25°C, V _{DD} =2.2V~5.5V		
	Frequency of IHRC after	15.20*	16* 16.80*	MHz	$V_{DD} = 2.2V \sim 5.5V$,			
f _{IHRC}	calibration *	13.60*	16*	18.40*		-20°C <ta<70°c* V_{DD} =1.8V~5.5V, -20°C <ta<70°c< td=""></ta<70°c<></ta<70°c* 		



Symbol	Description	Min	Тур	Max	Unit	Conditions (Ta=25°C)	
t _{INT}	Interrupt pulse width	30			ns	$V_{DD} = 5.0V$	
V_{DR}	RAM data retention voltage*	1.5			V	in stop mode	
			8k			misc[1:0]=00 (default)	
			16k		_	misc[1:0]=01	
t _{WDT}	Watchdog timeout period		64k		T_ILRC	misc[1:0]=10	
			256k			misc[1:0]=11	
	Wake-up time period for fast wake-up		45			Where T _{ILRC} is the time	
t _{WUP}	Wake-up time period for slow wake-up		3000		T_ILRC	period of ILRC	
_	System boot-up period from power-on for Slow boot-up		55		ms		
t _{SBP}	System boot-up period from power-on for Fast boot-up		820		us	V _{DD} =5V	
t _{RST}	External reset pulse width	120			us	@ V _{DD} =5V	
CPos	Comparator offset*		±10	±20	mV		
CPcm	Comparator input common mode*	0		V _{DD} -1.5	V		
CPspt	CPspt Comparator response time**		100	500	ns	Both Rising and Falling	
CPmc	Stable time to change comparator mode		2.5	7.5	us		
CPcs Comparator current consumption			20		uA	V _{DD} = 3.3V	

^{*}These parameters are for design reference, not tested for each chip.

4.2. Absolute Maximum Ratings

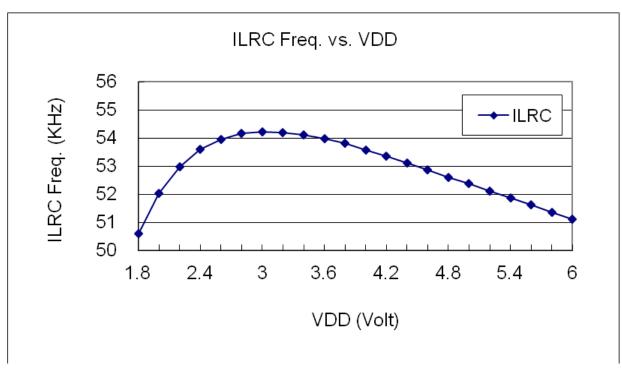
*If V_{DD} is over the maximum rating, it may lead to a permanent damage of IC.

Input Voltage -0.3V ~ V_{DD} + 0.3V

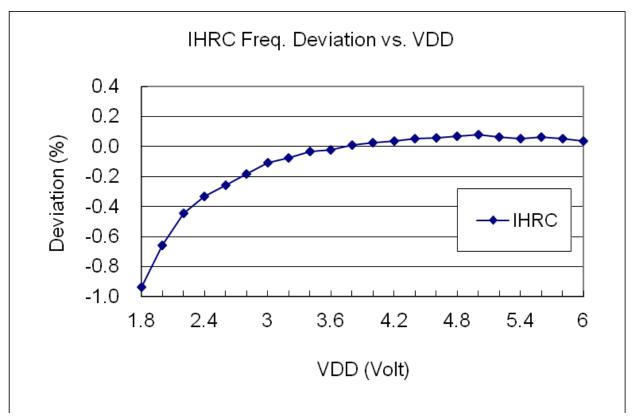
Operating Temperature-20°C ~ 70°C

● Storage Temperature-50°C ~ 125°C

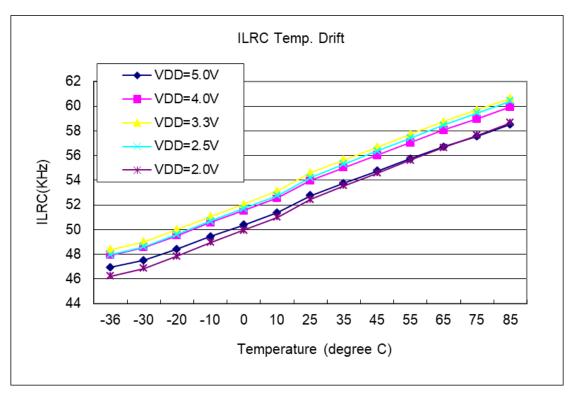
4.3. Typical ILRC frequency vs. VDD



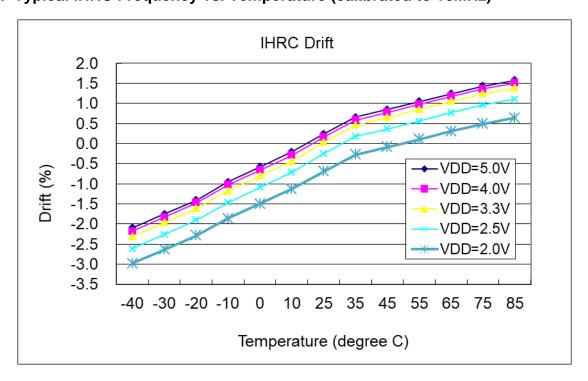
4.4. Typical IHRC frequency deviation vs. VDD(calibrated to 16MHz)



4.5. Typical ILRC Frequency vs. Temperature



4.6. Typical IHRC Frequency vs. Temperature (calibrated to 16MHz)

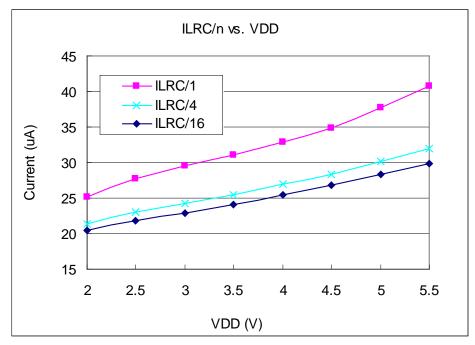


4.7. Typical operating current vs. VDD @ system clock = ILRC/n

Conditions:

ON: Band-gap, LVR, ILRC; OFF: IHRC, EOSC, T16, TM2;

IO: PA0:0.5Hz output toggle and no loading, others: input and no floating

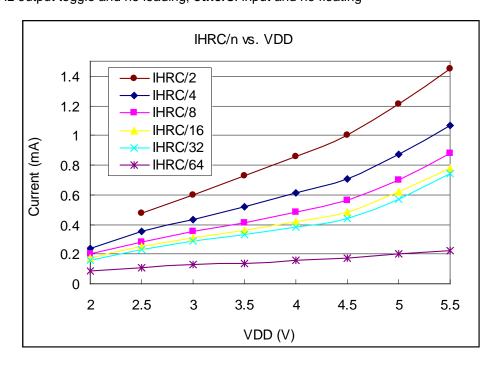


4.8. Typical operating current vs. VDD @ system clock = IHRC/n

Conditions:

ON: Band-gap, LVR, IHRC; OFF: ILRC, EOSC, T16, TM2;

IO: PA0:0.5Hz output toggle and no loading, others: input and no floating

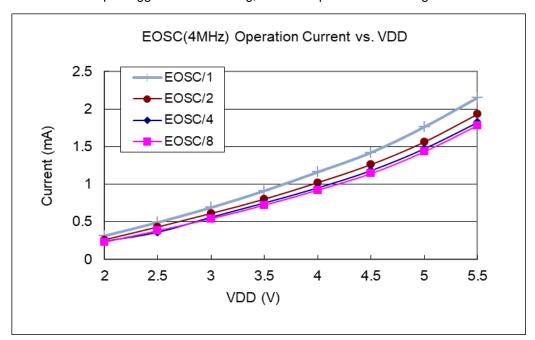


4.9. Typical operating current vs. VDD @ system clock = 4MHz EOSC / n

Conditions:

ON: Band-gap, LVR, EOSC; OFF:, IHRC, ILRC, T16, TM2;

IO: PA0:0.5Hz output toggle and no loading, others: input and no floating

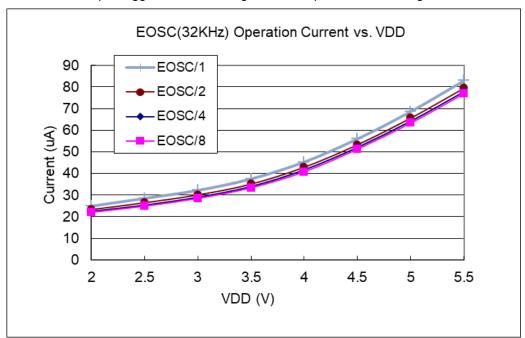


4.10. Typical operating current vs. VDD @ system clock = 32KHz EOSC / n

Conditions:

ON: Band-gap, LVR, EOSC; OFF: IHRC, ILRC, T16, TM2;

IO: PA0:0.5Hz output toggle and no loading, others: input and no floating



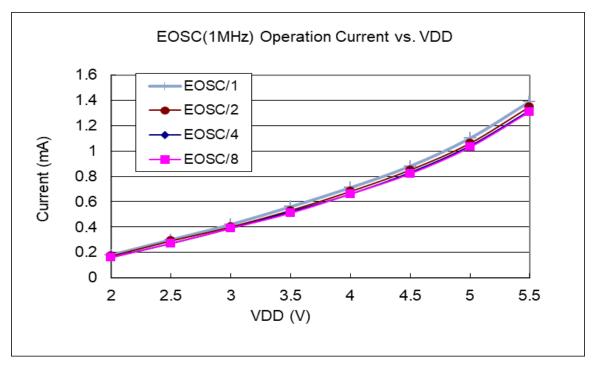


4.11. Typical operating current vs. VDD @ system clock = 1MHz EOSC / n

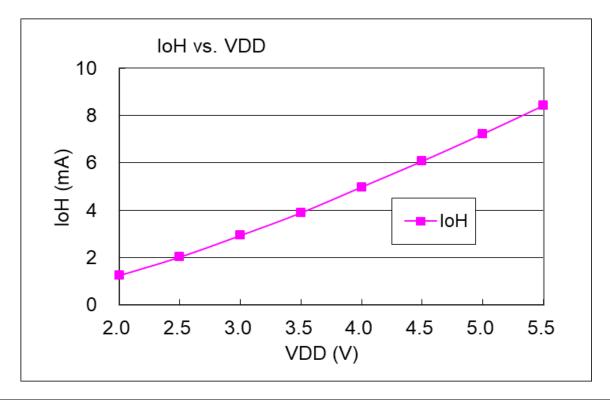
Conditions:

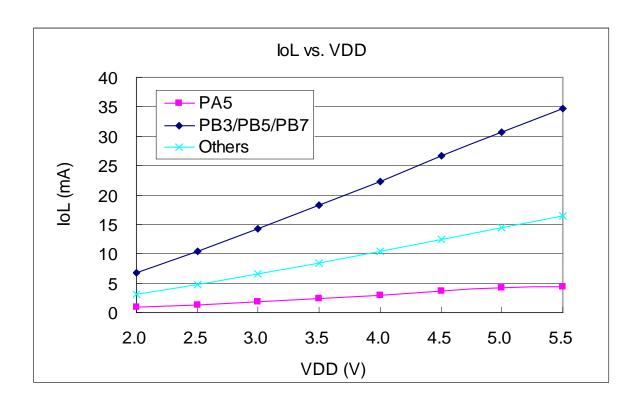
ON: Band-gap, LVR, EOSC; OFF: IHRC, ILRC, T16, TM2;

IO: PA0:0.5Hz output toggle and no loading, others: input and no floating

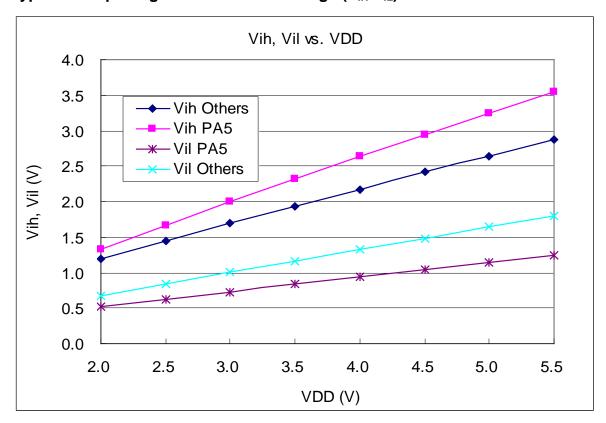


4.12. Typical IO driving current (I_{OH}) and sink current (I_{OL})

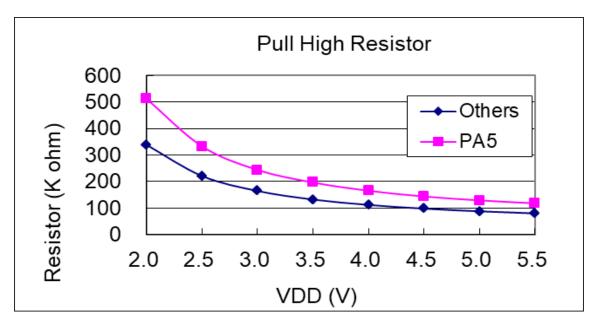




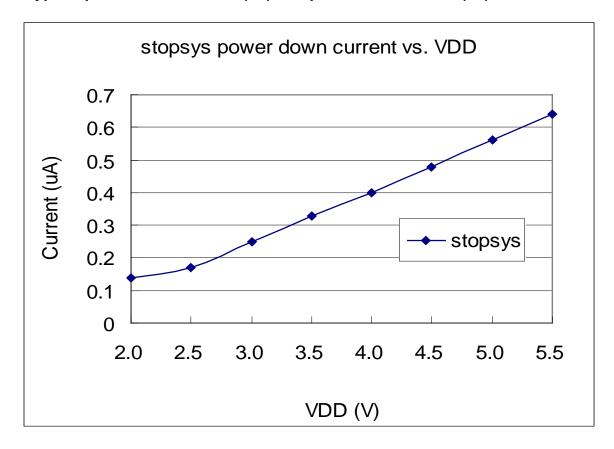
4.13. Typical IO input high/low threshold voltage (V_{IH}/V_{IL})



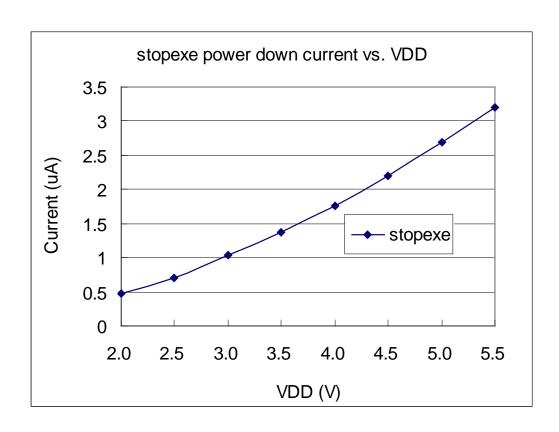
4.14. Typical resistance of IO pull high device



4.15. Typical power down current (I_{PD}) and power save current (I_{PS})









5. Functional Description

5.1. Program Memory - OTP

The OTP (One Time Programmable) program memory is used to store the program instructions to be executed. The OTP program memory may contains the data, tables and interrupt entry. After reset, the initial address 0x000 is reserved for system using, so the program will start from 0x001 which is GOTO FPPA0 instruction usually. The interrupt entry is 0x10 if used, the last 16 addresses are reserved for system using, like checksum, serial number, etc. The OTP program memory for PMS152 is 1.25KW that is partitioned as Table 1. The OTP memory from address '0x4E6 to 0x4FF is for system using, address space from0x002 to 0x00F and from 0x011 to 0x4E5 are user program spaces.

Address	Function		
0x000	System Using		
0x001	GOTO FPPA0 instruction		
0x002	User program		
•	•		
0x00F	User program		
0x010	Interrupt entry address		
0x011	User program		
•	•		
0x4E5	User program		
0x4E6	System Using		
•	•		
0x4FF	System Using		

Table 1: Program Memory Organization

5.2. Boot Procedure

POR (Power-On-Reset) is used to reset PMS152 when power up. The boot up time can be optional fast or normal. Time for fast boot-up is about 47 ILRC clock cycles whereas 2945 ILRC clock cycles for normal boot-up. Customer must ensure the stability of supply voltage after power up no matter which option is chosen, the power up sequence is shown in the Fig. 1 and t_{SBP} is the boot up time.

Please noted, during Power-On-Reset, the V_{DD} must go higher than V_{POR} to boot-up the MCU.

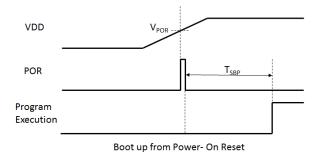
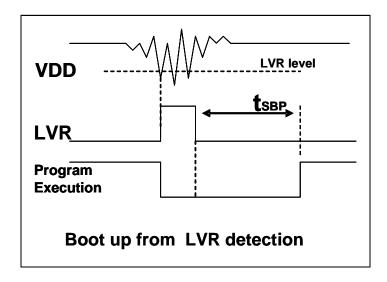
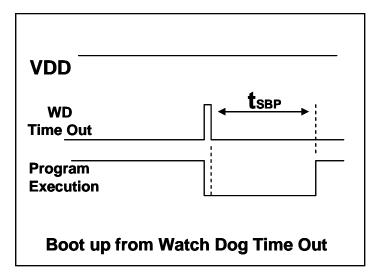
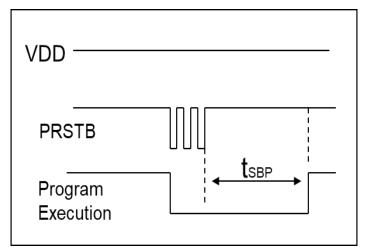


Fig.1: Power-Up Sequence

5.2.1. Timing charts for reset conditions









5.3. Data Memory - SRAM

The access of data memory can be byte or bit operation. Besides data storage, the SRAM data memory is also served as data pointer of indirect access method and the stack memory.

The stack memory is defined in the data memory. The stack pointer is defined in the stack pointer register; the depth of stack memory of each processing unit is defined by the user. The arrangement of stack memory fully flexible and can be dynamically adjusted by the user.

For indirect memory access mechanism, the data memory is used as the data pointer to address the data byte. All the data memory could be the data pointer; it's quite flexible and useful to do the indirect memory access. Since the data width is 8-bit, all the 80 bytes data memory of PMS152 can be accessed by indirect access mechanism.

5.4. Oscillator and Clock

There are three oscillator circuits provided by PMS152: external crystal oscillator (EOSC), internal high RC oscillator (IHRC) and internal low RC oscillator (ILRC), and these three oscillators are enabled or disabled by registers eoscr.7, clkmd.4 and clkmd.2 independently. User can choose one of these three oscillators as system clock source and use *clkmd* register to target the desired frequency as system clock to meet different applications.

Oscillator Module	Enable/Disable
EOSC	eoscr.7
IHRC	clkmd.4
ILRC	clkmd.2

Table 2: Three oscillation circuits

5.4.1. Internal High RC oscillator and Internal Low RC oscillator

After boot-up, the IHRC and ILRC oscillators are enabled. The frequency of IHRC can be calibrated to eliminate process variation by *ihrcr* register; normally it is calibrated to 16MHz. Please refer to the measurement chart for IHRC frequency verse V_{DD} and IHRC frequency verse temperature.

The frequency will vary by process, supply voltage and temperature, please refer to DC specification and do not use for accurate timing application.

5.4.2. Chip calibration

The IHRC frequency and band-gap reference voltage may be different chip by chip due to manufacturing variation, PMS152 provide the IHRC frequency calibration to eliminate this variation, and this function can be selected when compiling user's program and the command will be inserted into user's program automatically. The calibration command is shown as below:

.ADJUST_IC SYSCLK=IHRC/(p1), IHRC=(p2)MHz, V_{DD} =(p3)V;

Where, **p1**=2, 4, 8, 16, 32; In order to provide different system clock.

p2=14 ~ 18; In order to calibrate the chip to different frequency, 16MHz is the usually one.

p3=1.8 ~ 5.5; In order to calibrate the chip under different supply voltage.



5.4.3. IHRC Frequency Calibration and System Clock

During compiling the user program, the options for IHRC calibration and system clock are shown as Table 3:

SYSCLK	CLKMD	IHRCR	Description	
o Set IHRC / 2	= 34h (IHRC / 2)	Calibrated	IHRC calibrated to 16MHz, CLK=8MHz (IHRC/2)	
o Set IHRC / 4	= 14h (IHRC / 4)	Calibrated	IHRC calibrated to 16MHz, CLK=4MHz (IHRC/4)	
o Set IHRC / 8	= 3Ch (IHRC / 8)	Calibrated	IHRC calibrated to 16MHz, CLK=2MHz (IHRC/8)	
o Set IHRC / 16	= 1Ch (IHRC / 16)	Calibrated	IHRC calibrated to 16MHz, CLK=1MHz (IHRC/16)	
o Set IHRC / 32	= 7Ch (IHRC / 32)	Calibrated	IHRC calibrated to 16MHz, CLK=0.5MHz (IHRC/32)	
o Set ILRC	= E4h (ILRC / 1)	Calibrated	IHRC calibrated to 16MHz, CLK=ILRC	
o Disable	No change	No Change	IHRC not calibrated, CLK not changed	

Table 3: Options for IHRC Frequency Calibration

Usually, .ADJUST_IC will be the first command after boot up, in order to set the target operating frequency whenever starting the system. The program code for IHRC frequency calibration is executed only one time that occurs in writing the codes into OTP memory; after then, it will not be executed again. If the different option for IHRC calibration is chosen, the system status is also different after boot. The following shows the status of PMS152 for different option:

(1) .ADJUST_IC SYSCLK=IHRC/2, IHRC=16MHz, V_{DD}=5V

After boot up, CLKMD = 0x34:

- ♦ IHRC frequency is calibrated to 16MHz@V_{DD}=5V and IHRC module is enabled
- ◆ System CLK = IHRC/2 = 8MHz
- ♦ Watchdog timer is disabled, ILRC is enabled, PA5 is in input mode

(2) .ADJUST_IC SYSCLK=IHRC/4, IHRC=16MHz, V_{DD}=3.3V

After boot up, CLKMD = 0x14:

- ♦ IHRC frequency is calibrated to 16MHz@V_{DD}=3.3V and IHRC module is enabled
- ◆ System CLK = IHRC/4 = 4MHz
- ♦ Watchdog timer is disabled, ILRC is enabled, PA5 is in input mode

(3) .ADJUST_IC SYSCLK=IHRC/8, IHRC=16MHz, V_{DD}=2.5V

After boot up, CLKMD = 0x3C:

- ♦ IHRC frequency is calibrated to 16MHz@V_{DD}=2.5V and IHRC module is enabled
- ◆ System CLK = IHRC/8 = 2MHz
- ♦ Watchdog timer is disabled, ILRC is enabled, PA5 is in input mode

(4) .ADJUST_IC SYSCLK=IHRC/16, IHRC=16MHz, V_{DD}=2.5V

After boot up, CLKMD = 0x1C:

- ♦ IHRC frequency is calibrated to 16MHz@V_{DD}=2.5V and IHRC module is enabled
- ◆ System CLK = IHRC/16 = 1MHz
- ♦ Watchdog timer is disabled, ILRC is enabled, PA5 is in input mode

(5) .ADJUST_IC SYSCLK=IHRC/32, IHRC=16MHz, V_{DD}=5V

After boot up, CLKMD = 0x7C:

- ♦ IHRC frequency is calibrated to 16MHz@V_{DD}=5V and IHRC module is enabled
- ♦ System CLK = IHRC/32 = 500KHz
- ♦ Watchdog timer is disabled, ILRC is enabled, PA5 is in input mode



(6) .ADJUST_IC SYSCLK=ILRC, IHRC=16MHz, V_{DD}=5V

After boot up, CLKMD = 0XE4:

- ♦ IHRC frequency is calibrated to 16MHz@V_{DD}=5V and IHRC module is disabled
- ◆ System CLK = ILRC
- Watchdog timer is disabled, ILRC is enabled, PA5 is input mode

(7) .ADJUST_IC DISABLE

After boot up, CLKMD is not changed (Do nothing):

- IHRC is not calibrated
- System CLK = ILRC or IHRC/64 (by Boot-up_Time)
- ♦ Watchdog timer is enabled, ILRC is enabled, PA5 is in input mode,

5.4.4. External Crystal Oscillator

If crystal oscillator is used, a crystal or resonator is required between X1 and X2. Fig.2 shows the hardware connection under this application; the range of operating frequency of crystal oscillator can be from 32 KHz to 4MHz, depending on the crystal placed on; higher frequency oscillator than 4MHz is NOT supported.

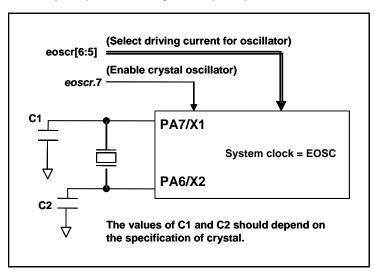


Fig.2: Connection of crystal oscillator

Besides crystal, external capacitor and options of PMS152 should be fine tuned in *eoscr* (0x0a) register to have good sinusoidal waveform. The *eoscr*.7 is used to enable crystal oscillator module, *eoscr*.6 and *eoscr*.5 are used to set the different driving current to meet the requirement of different frequency of crystal oscillator:

- eoscr.[6:5]=01 : Low driving capability, for lower frequency, ex: 32KHz crystal oscillator
- eoscr.[6:5]=10 : Middle driving capability, for middle frequency, ex: 1MHz crystal oscillator
- eoscr.[6:5]=11 : High driving capability, for higher frequency, ex: 4MHz crystal oscillator

Table 4 shows the recommended values of C1 and C2 for different crystal oscillator; the measured start-up time under its corresponding conditions is also shown. Since the crystal or resonator had its own characteristic, the capacitors and start-up time may be slightly different for different type of crystal or resonator, please refer to its specification for proper values of C1 and C2.

Frequency	C1	C2	Measured Start-up time	Conditions
4MHz	4.7pF	4.7pF	6ms	(eoscr[6:5]=11)
1MHz	10pF	10pF	11ms	(eoscr[6:5]=10)
32KHz	22pF	22pF	450ms	(eoscr[6:5]=01)

Table 4: Recommend values of C1 and C2 for crystal and resonator oscillators

When using the crystal oscillator, user must pay attention to the stable time of oscillator after enabling it, the stable time of oscillator will depend on frequency "crystal type" external capacitor and supply voltage. Before switching the system to the crystal oscillator, user must make sure the oscillator is stable; the reference program is shown as below:

```
void
       FPPA0 (void)
{
      . ADJUST_IC SYSCLK=IHRC/16, IHRC=16MHz, V<sub>DD</sub>=5V
                                           // EOSCR = 0b110 00000;
      $ EOSCR
                   Enable, 4MHz;
                                           // while T16.Bit13 0 => 1, Intrq.T16 => 1
      $ T16M
                   EOSC, /1, BIT13;
                                            // suppose crystal EOSC is stable
      WORD
                   count =
                               0:
      stt16 count;
      Intrq.T16
                               0;
      while(!Intrq.T16) { nop; };
                                            // count from 0x0000 to 0x2000, then trigger INTRQ.T16
                                            // switch system clock to EOSC;
      clkmd
                               0xB4;
      Clkmd.4 = 0;
                                            // disable IHRC
}
```

Please notice that the crystal oscillator should be fully turned off before entering the power-down mode, in order to avoid unexpected wake-up event.



5.4.5. System Clock and LVR level

The clock source of system clock comes from EOSC, IHRC and ILRC, the hardware diagram of system clock in the PMS152 is shown as Fig.3.

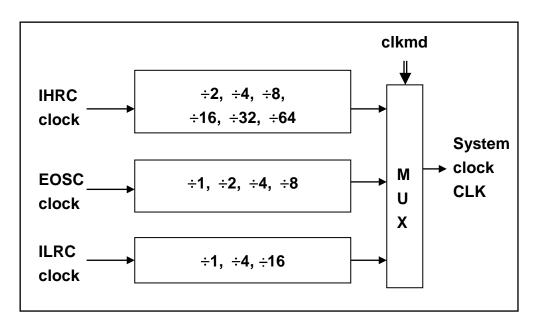


Fig.3: Options of System Clock

User can choose different operating system clock depends on its requirement; the selected operating system clock should be combined with supply voltage and LVR level to make system stable. The LVR level will be selected during compilation. Please refer to Section 4.1.



5.4.6. System Clock Switching

After IHRC calibration, user may want to switch system clock to a new frequency or may switch system clock at any time to optimize the system performance and power consumption. Basically, the system clock of PMS152 can be switched among IHRC, ILRC and EOSC by setting the *clkmd* register at any time; system clock will be the new one after writing to *clkmd* register immediately. Please notice that the original clock module can NOT be turned off at the same time as writing command to *clkmd* register. The examples are shown as below and more information about clock switching, please refer to the "Help" -> "Application Note" -> "IC Introduction" -> "Register Introduction" -> CLKMD".

```
Case 1: Switching system clock from ILRC to IHRC/2
                                                   system clock is ILRC
      CLKMD.4
                                            //
                                                   turn on IHRC first to improve anti-interference ability
                                1;
      CLKMD
                                0x34;
                                            //
                                                   switch to IHRC/2, ILRC CAN NOT be disabled here
      // CLKMD.2
                                0;
                                            //
                                                   if need, ILRC CAN be disabled at this time
Case 2: Switching system clock from ILRC to EOSC
                                            //
                                                   system clock is ILRC
      CLKMD
                                            //
                                                   switch to IHRC, ILRC CAN NOT be disabled here
                                0xA6;
      CLKMD.2
                                0;
                                            //
                                                   ILRC CAN be disabled at this time
Case 3: Switching system clock from IHRC/2 to ILRC
                                            //
                                                   system clock is IHRC/2
                                            //
                                                   switch to ILRC, IHRC CAN NOT be disabled here
      CLKMD
                                0xF4;
      CLKMD.4
                                            //
                                0;
                                                   IHRC CAN be disabled at this time
Case 4: Switching system clock from IHRC/2 to EOSC
                                            //
                                                   system clock is IHRC/2
                                                   switch to EOSC, IHRC CAN NOT be disabled here
      CLKMD
                                0XB0;
                                            //
                                            //
      CLKMD.4
                                0;
                                                   IHRC CAN be disabled at this time
Case 5: Switching system clock from IHRC/2 to IHRC/4
                                            //
                                                   system clock is IHRC/2, ILRC is enabled here
      CLKMD
                                0X14;
                                            //
                                                   switch to IHRC/4
Case 6: System may hang if it is to switch clock and turn off original oscillator at the same time
                                            //
                                                   system clock is ILRC
      CLKMD
                                            //
                                                   CAN NOT switch clock from ILRC to IHRC/2 and
                                0x30;
```

turn off ILRC oscillator at the same time



5.5. Comparator

One hardware comparator is built inside the PMS152; Fig.4 shows its hardware diagram. It can compare signals between two pins or with either internal reference voltage V_{internal R} or internal band-gap reference voltage. The two signals to be compared, one is the plus input and the other one is the minus input. For the minus input of comparator can be PA3, PA4, Internal band-gap 1.20 volt, PB6, PB7 or V_{internal R} selected by bit [3:1] of gpcc register, and the plus input of comparator can be PA4 or V_{internal R} selected by bit 0 of gpcc register. The output result can be enabled to output to PA0 directly, or sampled by Time2 clock (TM2_CLK) which comes from Timer2 module. The output can be also inversed the polarity by bit 4 of *gpcc* register, the comparator output can be used to request interrupt service.

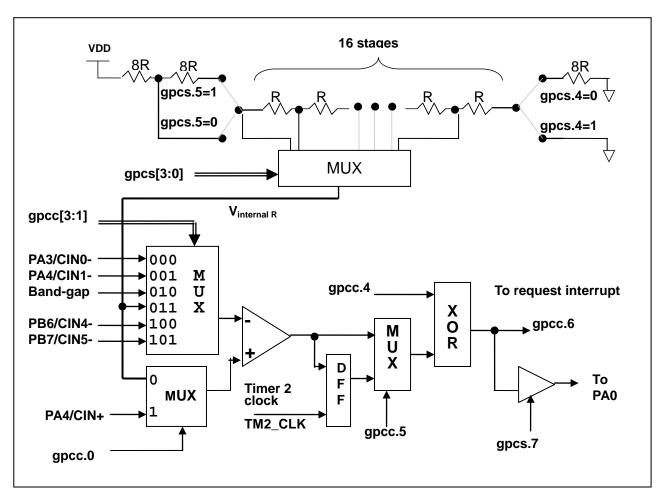


Fig.4: Hardware diagram of comparator

5.5.1 Internal reference voltage (V_{internal R})

The internal reference voltage $V_{internal\ R}$ is built by series resistance to provide different level of reference voltage, bit 4 and bit 5 of *gpcs* register are used to select the maximum and minimum values of $V_{internal\ R}$ and bit [3:0] of *gpcs* register are used to select one of the voltage level which is deivided-by-16 from the defined maximum level to minimum level. Fig.5 to Fig.8 shows four conditions to have different reference voltage $V_{internal\ R}$. By setting the *gpcs* register, the internal reference voltage $V_{internal\ R}$ can be ranged from $(1/32)^*V_{DD}$ to $(3/4)^*V_{DD}$.

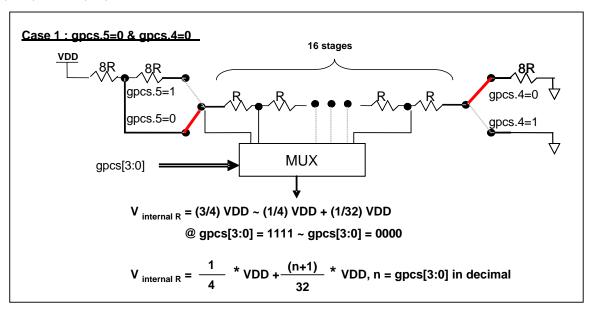


Fig.5: V_{internal R} hardware connection if gpcs.5=0 and gpcs.4=0

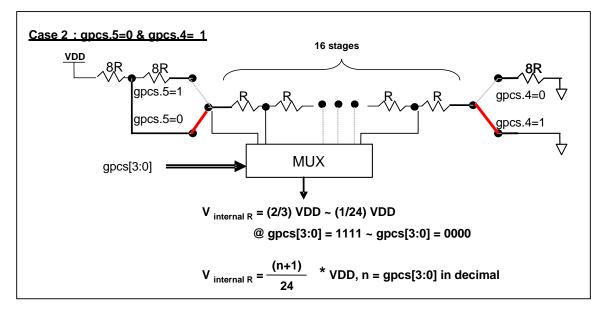


Fig.6: V_{internal R} hardware connection if gpcs.5=0 and gpcs.4=1

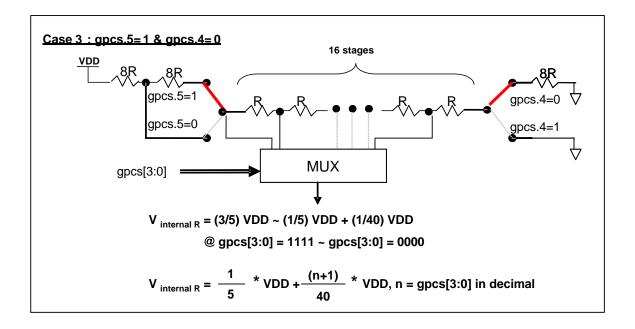


Fig.7: V_{internal R} hardware connection if gpcs.5=1 and gpcs.4=0

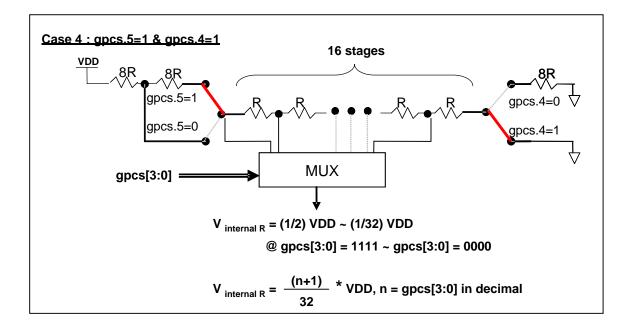


Fig.8: V_{internal R} hardware connection if gpcs.5=1 and gpcs.4=1



5.5.2 Using the comparator

Case I:

Choosing PA3 as minus input and $V_{internal\ R}$ with $(18/32)^*V_{DD}$ voltage level as plus input. $V_{internal\ R}$ is configured as the above Figure "gpcs[5:4] = 2b'00" and gpcs [3:0] = 4b'1001 (n=9) to have $V_{internal\ R}$ = $(1/4)^*V_{DD} + [(9+1)/32]^*V_{DD} = [(9+9)/32]^*V_{DD} = (18/32)^*V_{DD}$.

or

```
$ GPCS V_{DD}*18/32;
$ GPCC Enable, N_PA3, P_R; //- input: N_xx, + input: P_R(V_{internal R})
PADIER = 0bxxxx_0_xxx;
```

Case 2:

Choosing $V_{internal\ R}$ as minus input with $(22/40)^*V_{DD}$ voltage level and PA4 as plus input, the comparator result will be inversed and then output to PA0. $V_{internal\ R}$ is configured as the above Figure "gpcs[5:4] = 2b'10" and gpcs [3:0] = 4b'1101 (n=13) to have $V_{internal\ R} = (1/5)^*V_{DD} + [(13+1)/40]^*V_{DD} = [(13+9)/40]^*V_{DD} = (22/40)^*V_{DD}$.

```
appcs = 0b1_0_10_1101;// output to PA0, V_{internal\,R} = V_{DD}^*(22/40)appcc = 0b1_0_0_1_011_1;// Inverse output, - input: V_{internal\,R}, + input: PA4appadier = 0bxxx_0_xxx;// disable PA4 digital input to prevent leakage current
```

or

```
$ GPCS Output, V_{DD}*22/40;
$ GPCC Enable, Inverse, N_R, P_PA4; //- input: N_R(V_{internal\ R}), + input: P_xx
PADIER = 0bxxx_0_xxx;
```

Note: When selecting output to PA0 output, GPCS will affect the PA3 output function in ICE. Though the IC is fine, be careful to avoid this error during emulation.



{ }

PMS152 8bit OTP Type SuLED IO Controller

5.5.3 Using the comparator and band-gap 1.20V

The internal band-gap module can provide 1.20 volt, it can measure the external supply voltage level. The band-gap 1.20 volt is selected as minus input of comparator and $V_{internal\ R}$ is selected as plus input, the supply voltage of $V_{internal\ R}$ is V_{DD} , the V_{DD} voltage level can be detected by adjusting the voltage level of $V_{internal\ R}$ to compare with band-gap. If N (gpcs[3:0] in decimal) is the number to let $V_{internal\ R}$ closest to band-gap 1.20 volt, the supply voltage V_{DD} can be calculated by using the following equations:

when $V_{DD} < 4V$



5.6 16-bit Timer (Timer16)

A 16-bit hardware timer (Timer16) is implemented in the PMS152, the clock sources of Timer16 may come from system clock (CLK), clock of external crystal oscillator (EOSC), internal high RC oscillator (IHRC), internal low RC oscillator (ILRC), PA4 and PA0, a multiplex is used to select clock output for the clock source. Before sending clock to the counter16, a pre-scaling logic with divided-by-1, 4, 16, and 64 is used for wide range counting. The 16-bit counter performs up-counting operation only, the counter initial values can be stored from memory by *stt16* instruction and the counting values can be loaded to memory by *ldt16* instruction. A selector is used to select the interrupt condition of Timer16, whenever overflow occurs, the Timer16 interrupt can be triggered. The hardware diagram of Timer16 is shown as Fig.9. The interrupt source of Timer16 comes from one of bit 8 to 15 of 16-bit counter, and the interrupt type can be rising edge trigger or falling edge trigger which is specified in the bit 5 of *integs* register (address 0x0C).

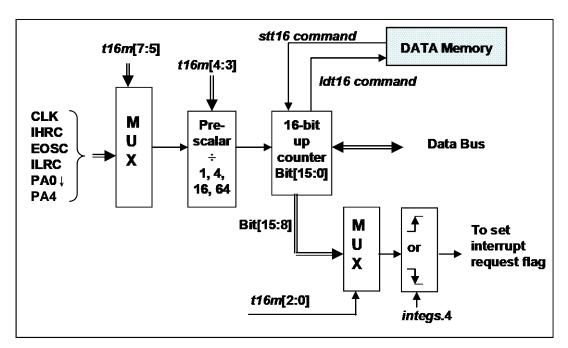


Fig.9: Hardware diagram of Timer16

When using the Timer16, the syntax for Timer16 has been defined in the .INC file. There are three parameters to define the Timer16; 1st parameter is used to define the clock source of Timer16, 2nd parameter is used to define the pre-scalar and the last one is to define the interrupt source. The detail description is shown as below:



User can define the parameters of T16M based on system requirement, some examples are shown below and more examples please refer to "Help \rightarrow Application Note \rightarrow IC Introduction \rightarrow Register Introduction \rightarrow T16M" in IDE utility.

\$ T16M SYSCLK, /64, BIT15;

```
// choose (SYSCLK/64) as clock source, every 2^16 clock to set INTRQ.2=1
// if using System Clock = IHRC / 2 = 8 MHz
// SYSCLK/64 = 8 MHz/64 = 125KHz, about every 512 mS to generate INTRQ.2=1
```

\$ T16M EOSC, /1, BIT13;

// choose (EOSC/1) as clock source, every 2^14 clocks to generate INTRQ.2=1 // if EOSC=32768 Hz, 32768 Hz/(2^14) = 2Hz, every 0.5S to generate INTRQ.2=1

\$ T16M PAO_F, /1, BIT8;

// choose PA0 as clock source, every 2^9 to generate INTRQ.2=1 // receiving every 512 times PA0 to generate INTRQ.2=1

\$ T16M STOP;

// stop Timer16 counting

If Timer16 is operated at free running, the frequency of interrupt can be described as below:

 $F_{INTRQ_T16M} = F_{clock source} \div P \div 2^{n+1}$

Where, F is the frequency of selected clock source to Timer16;

P is the selection of t16m [4:3]; (1, 4, 16, 64)

N is the nth bit selected to request interrupt service, for example: n=10 if bit 10 is selected.



5.7 8-bit Timer (Timer2) with PWM generation

An 8-bit hardware timer (Timer2) with PWM generation is implemented in the PMS152. Please refer to Fig.10 shown the hardware diagram of Timer2, the clock sources of Timer2 may come from system clock, internal high RC oscillator (IHRC), internal low RC oscillator (ILRC), external crystal oscillator (EOSC), PA0, PB0, PA4 and comparator. Bit [7:4] of register tm2c are used to select the clock of Timer2. If IHRC is selected for Timer2 clock source, the clock sent to Timer2 will keep running when using ICE in halt state. The output of Timer2 can be sent to pin PB2, PA3 or PB4, depending on bit [3:2] of tm2c register. A clock pre-scaling module is provided with divided-by- 1, 4, 16, and 64 options, controlled by bit [6:5] of tm2s register; one scaling module with divided-by-1~31 is also provided and controlled by bit [4:0] of tm2s register. In conjunction of pre-scaling function and scaling function, the frequency of Timer2 clock (TM2_CLK) can be wide range and flexible.

The Timer2 counter performs 8-bit up-counting operation only; the counter values can be set or read back by tm2ct register. The 8-bit counter will be clear to zero automatically when its values reach for upper bound register in period mode. The upper bound register is used to define the period of timer or duty of PWM. There are two operating modes for Timer2: period mode and PWM mode; period mode is used to generate periodical output waveform or interrupt event; PWM mode is used to generate PWM output waveform with optional 6-bit, 7-bit or 8-bit PWM resolution, Fig.11 shows the timing diagram of Timer2 for both period mode and PWM mode.

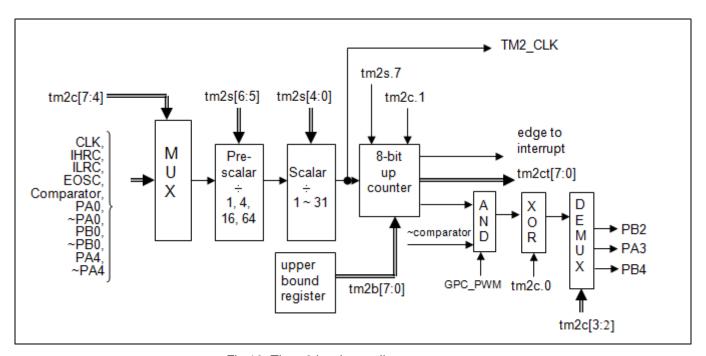


Fig.10: Timer2 hardware diagram



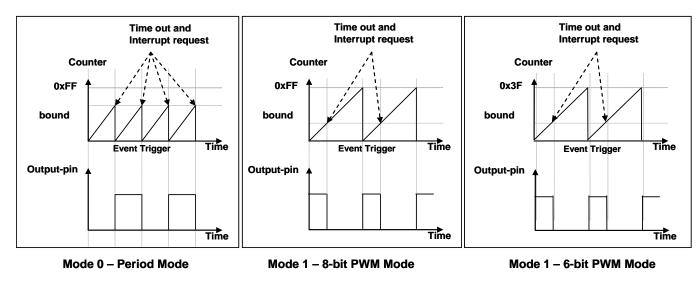


Fig.11: Timing diagram of Timer2 in period mode and PWM mode (tm2c.1=1)

A Code Option GPC_PWM is for the applications which need the generated PWM waveform to be controlled by the comparator result. If the Code Option GPC_PWM is selected, the PWM output stops while the comparator output is 1 and then the PWM output turns on while the comparator output goes back to 0, as shown in Fig. 12.

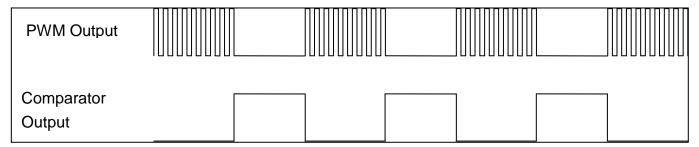


Fig.12: Comparator controls the output of PWM waveform

5.7.1 Using the Timer2 to generate periodical waveform

If periodical mode is selected, the duty cycle of output is always 50%; its frequency can be summarized as below:

Frequency of Output = $Y \div [2 \times (K+1) \times S1 \times (S2+1)]$

Where, Y = tm2c[7:4]: frequency of selected clock source

K = tm2b[7:0]: bound register in decimal

S1 = tm2s[6:5]: pre-scalar (S1=1, 4, 16, 64)

S2 = tm2s[4:0]: scalar register in decimal ($S2=0 \sim 31$)

Example 1:

 $tm2c = 0b0001_1000, Y=8MHz$

 $tm2b = 0b0111_1111, K=127$

 $tm2s = 0b0000_00000$, S1=1, S2=0

→ frequency of output = 8MHz ÷ $[2 \times (127+1) \times 1 \times (0+1)] = 31.25$ KHz

Example 2:

```
tm2c = 0b0001_1000, Y=8MHz

tm2b = 0b0111_1111, K=127

tm2s[7:0] = 0b0111_11111, S1=64, S2 = 31

\rightarrow frequency of output = 8MHz \div ( 2 × (127+1) × 64 × (31+1) ) =15.25Hz
```

Example 3:

```
tm2c = 0b0001_1000, Y=8MHz

tm2b = 0b0000_1111, K=15

tm2s = 0b0000_00000, S1=1, S2=0

\rightarrow frequency of output = 8MHz \div ( 2 × (15+1) × 1 × (0+1) ) = 250KHz
```

Example 4:

```
tm2c = 0b0001_1000, Y=8MHz

tm2b = 0b0000_0001, K=1

tm2s = 0b0000_00000, S1=1, S2=0

→ frequency of output = 8MHz ÷ (2 × (1+1) × 1 × (0+1)) =2MHz
```

The sample program for using the Timer2 to generate periodical waveform from PA3 is shown as below:

5.7.2 Using the Timer2 to generate 8-bit PWM waveform

If 8-bit PWM mode is selected, it should set *tm2c*[1]=1 and *tm2s*[7]=0, the frequency and duty cycle of output waveform can be summarized as below:

Frequency of Output = $Y \div [256 \times S1 \times (S2+1)]$ Duty of Output = $[(K+1) \div 256] \times 100\%$

Where, Y = tm2c[7:4]: frequency of selected clock source

K = tm2b[7:0]: bound register in decimal

S1= tm2s[6:5] : pre-scalar (S1=1, 4, 16, 64)

S2 = tm2s[4:0]: scalar register in decimal ($S2=0 \sim 31$)

Example 1:

 $tm2c = 0b0001_1010, Y=8MHz$

 $tm2b = 0b0111_1111, K=127$

 $tm2s = 0b0000_00000, S1=1, S2=0$

 \rightarrow frequency of output = 8MHz \div (256 \times 1 \times (0+1)) = 31.25KHz

 \rightarrow duty of output = [(127+1) \div 256] \times 100% = 50%

Example 2:

 $tm2c = 0b0001_1010, Y=8MHz$

 $tm2b = 0b0111_1111, K=127$

 \rightarrow frequency of output = 8MHz \div (256 \times 64 \times (31+1)) = 15.25Hz

 \rightarrow duty of output = [(127+1) \div 256] \times 100% = 50%

Example 3:

 $tm2c = 0b0001_1010, Y=8MHz$

 $tm2b = 0b1111_1111, K=255$

 $tm2s = 0b0000_00000, S1=1, S2=0$

→ PWM output keep high

 \rightarrow duty of output = [(255+1) \div 256] \times 100% = 100%

Example 4:

 $tm2c = 0b0001_1010, Y=8MHz$

 $tm2b = 0b0000_1001, K = 9$

 $tm2s = 0b0000_00000$, S1=1, S2=0

→ frequency of output = 8MHz \div (256 × 1 × (0+1)) = 31.25KHz

 \rightarrow duty of output = [(9+1) \div 256] \times 100% = 3.9%

The sample program for using the Timer2 to generate PWM waveform from PA3 is shown as below:

```
void
       FPPA0 (void)
{
    .ADJUST_IC
                    SYSCLK=IHRC/2, IHRC=16MHz, V<sub>DD</sub>=5V
    wdreset;
   tm2ct = 0x0:
   tm2b = 0x7f;
   tm2s = 0b0_00_000001;
                                       //
                                              8-bit PWM, pre-scalar = 1, scalar = 2
   tm2c = 0b0001\_10\_1\_0;
                                       //
                                              system clock, output=PA3, PWM mode
   while(1)
   {
         nop;
}
```

5.7.3 Using the Timer2 to generate 6-bit PWM waveform

If 6-bit PWM mode is selected, it should set *tm2c*[1]=1 and *tm2s*[7]=1, the frequency and duty cycle of output waveform can be summarized as below:

```
Frequency of Output = Y \div [64 \times S1 \times (S2+1)]
Duty of Output = [(K+1) \div 64] \times 100\%
```

```
Where, tm2c[7:4] = Y: frequency of selected clock source tm2b[7:0] = K: bound register in decimal tm2s[6:5] = S1: pre-scalar (S1=1, 4, 16, 64) tm2s[4:0] = S2: scalar register in decimal (S2=0 ~ 31)
```

Users can set Timer2 to be 7-bit PWM mode instead of 6-bit mode by using **TM2_Bit** code option. At that time, the calculation factors of the above equations become 128 instead of 64.

Example 1:

```
tm2c = 0b0001_1010, Y=8MHz

tm2b = 0b0001_1111, K=31

tm2s = 0b1000_00000, S1=1, S2=0

→ frequency of output = 8MHz ÷ (64 × 1 × (0+1)) = 125KHz

→ duty = [(31+1) ÷ 64] × 100% = 50%

Example 2:

tm2c = 0b0001_1010, Y=8MHz

tm2b = 0b0001_1111, K=31

tm2s = 0b1111_11111, S1=64, S2=31

→ frequency of output = 8MHz ÷ (64 × 64 × (31+1)) = 61.03 Hz

→ duty of output = [(31+1) ÷ 64] × 100% = 50%
```

Example 3:

tm2c = 0b0001_1010, Y=8MHz tm2b = 0b0011_1111, K=63

 $tm2s = 0b1000_00000$, S1=1, S2=0

- → PWM output keep high
- \rightarrow duty of output = [(63+1) \div 64] \times 100% = 100%

Example 4:

 $tm2c = 0b0001_1010, Y=8MHz$

tm2b = 0b0000 0000, K=0

 $tm2s = 0b1000_00000$, S1=1, S2=0

- → frequency = 8MHz ÷ (64 x 1 x (0+1)) = 125KHz
- \rightarrow duty = [(0+1) \div 64] \times 100% =1.5%

5.8 11-bit PWM Generators

One set of triple 11-bit SuLED (Super LED) hardware PWM generator is implemented in the PMS152. It consists of three PWM generators (PWMG0, PWMG1 & PWMG2). Their individual outputs are listed as below:

- PWMG0 PA0, PB4, PB5
- PWMG1 PA4, PB6, PB7
- PWMG2 PA3, PB2, PB3, PA5 (open drain output only)

Note: PDK5S-I-S01/2(B) doesn't support the function of the set of 11-bit SuLED hardware PWM generators.

5.8.1 PWM Waveform

A PWM output waveform (Fig.13) has a time-base (T_{Period} = Time of Period) and a time with output high level (Duty Cycle). The frequency of the PWM output is the inverse of the period (f_{PWM} = $1/T_{Period}$).

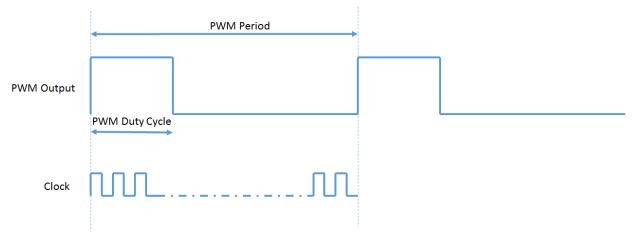


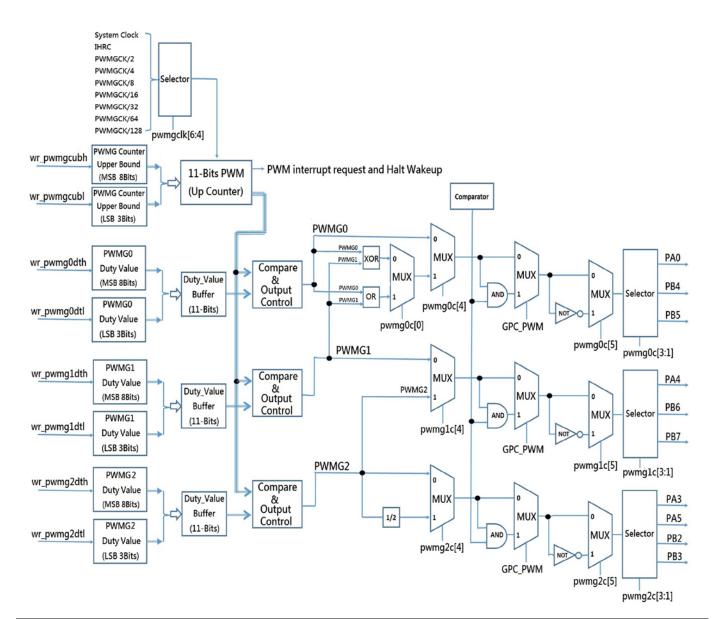
Fig.13: PWM Output Waveform



5.8.2 Hardware Diagram

Fig.14 shows the hardware diagram of the whole set of SuLED 11-bit hardware PWM generators. Those three PWM generators use a common Up-Counter and clock source selector to create the time base, and so the start points (the rising edge) of the PWM cycle are synchronized. The clock source can be IHRC or system clock. The PWM signal output pins that can be selected via *pwmgxc* register selection. The period of PWM waveform is defined by the common PWM upper bound high and low registers, and the duty cycle of individual PWM waveform is defined by the individual set in the PWM duty high and low registers.

The additional OR and XOR logic of PWMG0 channel is used to create the complementary switching waveforms with dead zone control. Selecting code option GPC_PWM can also control the generated PWM waveform by the comparator result.



Output Timing Diagram for 11- bit PWM generation

Fig.14: Hardware diagram of whole set of triple SuLED 11-bit PWM generators

Fig.15: Output Timing Diagram of 11-bit PWM Generator

5.8.3 Equations for 11-bit PWM Generator

```
PWM Frequency F_{PWM} = F_{clock \ source} \div [P \times (CB10_1 + 1)]
PWM Duty(in time) = (1 / F_{PWM}) \times (DB10_1 + DB0 \times 0.5 + 0.5) \div (CB10_1 + 1)
PWM Duty(in percentage) = (DB10_1 + DB0 \times 0.5 + 0.5) \div (CB10_1 + 1) \times 100\%
```

Where,

P = *PWMGCLK* [6:4]; pre-scalar **P**=1, 2, 4, 8, 16, 32, 64, 128

DB10_1 = Duty_Bound[10:1] = {PWMGxDTH[7:0], PWMGxDTL[7:6]}, duty bound

DB0 = Duty_Bound[0] = *PWMGxDTL[5*]

CB10_1 = Counter_Bound[10:1] = {PWMGCUBH/7:0], PWMGCUBL[7:6]}, counter bound

5.8.4 PWM Waveforms with Complementary Dead Zones

Based on the specific 11 bit PWM architecture of PMS152, here we employ PWM2 output and PWM0 inverse output after PWM0 xor PWM1 to generate two PWM waveforms with complementary dead zones.

Example program is as follows:

#define	dead_zone	10	//	dead time = 10% * (1/PWM_Frequency) us
#define	PWM_Pulse	<i>50</i>	//	set 50% as PWM duty cycle
				• •
#dofine	DIMM Dules 1	25	//	act 25% on DWM duty avala
#aeiiiie	PWM_Pulse_1	35	//	set 35% as PWM duty cycle
#define	PWM Pulse 2	60	//	set 60% as PWM duty cycle
				, ,



400*2 #define switch_time adjusting switch time //Note: To avoid noise, switch_time must be a multiple of PWM period. In this example PWM period = 400us, // so switch_time = 400^2 us. void FPPA0 (void) .ADJUST_IC SYSCLK=IHRC/16, IHRC=16MHz, VDD=5V; //---- Set the counter upper bound and duty cycle -----**PWMG0DTL** 0x00; **PWMG0DTH** PWM_Pulse + dead_zone; PWMG1DTL 0x00; PWMG1DTH dead_zone; // After PWMG0 xor PWMG, PWM duty cycle=PWM_Pulse% PWMG2DTL 0x00; PWMG2DTH PWM_Pulse + dead_zone*2; **PWMGCUBL** 0x00; **PWMGCUBH** 100; //---- Configure clock and pre-scalar -----\$ PWMGCLK Enable, /1, sysclk; //----- Output control -----\$ PWMG0C Enable,Inverse,PWM_Gen,PA0,gen_xor; // After PWMG0 xor PWMG, // output the inversed waveform through PA0 \$ PWMG1C Enable, PWMG1, disable; // disable PWMG1 output Enable, PA3; \$ PWMG2C output PWMG2 waveform through PA3 // while(1) { // To avoid the possible instant disappearance of dead zone, user should comply with the following // instruction sequence. // When increase the duty cycle: $50\%/60\% \rightarrow 35\%$ PWMG0DTL = 0x00: PWMG0DTH= PWM_Pulse_1 + dead_zone; PWMG2DTL =0x00; PWMG2DTH= PWM_Pulse_1 + dead_zone*2; .delay switch_time // When decrease the duty cycle: $35\% \rightarrow 60\%$ PWMG2DTL = 0x00; PWMG2DTH= PWM_Pulse_2 + dead_zone*2; PWMG0DTL = 0x00; PWM_Pulse_2 + dead_zone; PWMG0DTH= .delay switch_time

} }

The following figures show the waveforms at different condition.

1. The PWM waveform in a fixed-duty cycle:

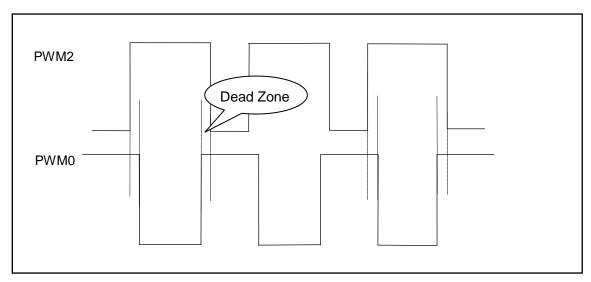


Fig.16: Complementary PWM waveform with dead zones

2. PWM waveform when switching two duty cycles:

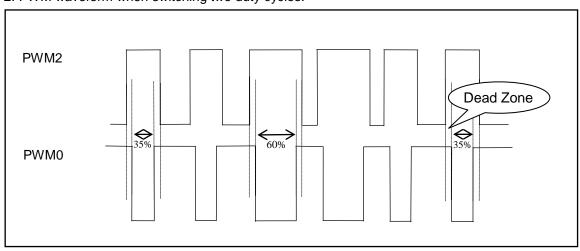


Fig.17: Complementary PWM waveform with dead zones

User can find that above example only provides dead zone where PWM are both in high. If need dead zone where PWM are both in low, you can realize it by resetting each control register's Inverse like:

\$ PWMG0C Enable, PWM_Gen, PA0, gen_xor;

\$ PWMG2C Enable, Inverse, PA3;.



5.9 WatchDog Timer

The watchdog timer (WDT) is a counter with clock coming from ILRC. WDT can be cleared by power-on-reset or by command **wdreset** at any time. There are four different timeout periods of watchdog timer to be chosen by setting the **misc** register, it is:

- ♦ 8k ILRC clocks period if register misc[1:0]=00 (default)
- ◆ 16k ILRC clocks period if register misc[1:0]=01
- ◆ 64k ILRC clocks period if register misc[1:0]=10
- ◆ 256k ILRC clocks period if register misc[1:0]=11

The frequency of ILRC may drift a lot due to the variation of manufacture, supply voltage and temperature; user should reserve guard band for save operation. Besides, the watchdog period will also be shorter than expected after Reset or Wakeup events. It is suggested to clear WDT by wdreset command after these events to ensure enough clock periods before WDT timeout.

When WDT is timeout, PMS152 will be reset to restart the program execution. The relative timing diagram of watchdog timer is shown as Fig.18.

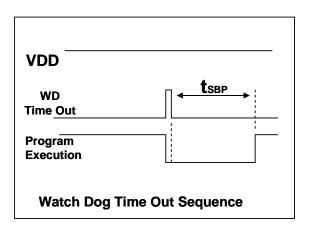


Fig.18: Sequence of Watch Dog Time Out



5.10. Interrupt

There are eight interrupt lines for PMS152:

- ◆ External interrupt PA0/PB5
- ◆ External interrupt PB0/PA4
- ◆ Timer16 interrupt
- ◆ GPC interrupt
- ◆ PWMG interrupt
- ◆ Timer2 interrupt

Every interrupt request line has its own corresponding interrupt control bit to enable or disable it; the hardware diagram of interrupt function is shown as Fig.19. All the interrupt request flags are set by hardware and cleared by writing *intrq* register. When the request flags are set, it can be rising edge, falling edge or both, depending on the setting of register *integs*. All the interrupt request lines are also controlled by *engint* instruction (enable global interrupt) to enable interrupt operation and *disgint* instruction (disable global interrupt) to disable it.

The stack memory for interrupt is shared with data memory and its address is specified by stack register *sp*. Since the program counter is 16 bits width, the bit 0 of stack register *sp* should be kept 0. Moreover, user can use *pushaf* / *popaf* instructions to store or restore the values of *ACC* and *flag* register *to* / *from* stack memory. Since the stack memory is shared with data memory, the stack position and level are arranged by the compiler in Mini-C project. When defining the stack level in ASM project, users should arrange their locations carefully to prevent address conflicts.

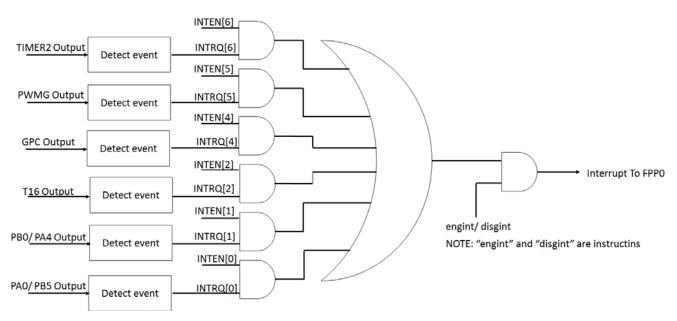


Fig.19: Hardware diagram of interrupt controller

Once the interrupt occurs, its operation will be:

- ◆ The program counter will be stored automatically to the stack memory specified by register sp.
- ♦ New sp will be updated to sp+2.
- Global interrupt will be disabled automatically.
- ◆ The next instruction will be fetched from address 0x010.



During the interrupt service routine, the interrupt source can be determined by reading the *intrq* register. Note: Even if INTEN=0, INTRQ will be still triggered by the interrupt source.

After finishing the interrupt service routine and issuing the reti instruction to return back, its operation will be:

- ◆ The program counter will be restored automatically from the stack memory specified by register sp.
- ♦ New sp will be updated to sp-2.
- Global interrupt will be enabled automatically.
- ◆ The next instruction will be the original one before interrupt.

User must reserve enough stack memory for interrupt, two bytes stack memory for one level interrupt and four bytes for two levels interrupt. And so on, two bytes stack memory is for *pushaf*. For interrupt operation, the following sample program shows how to handle the interrupt, noticing that it needs four bytes stack memory to handle one level interrupt and *pushaf*.

```
void
               FPPA0 (void)
 {
                           // INTEN =1; interrupt request when PA0 level changed
     $ INTEN PAO;
                           // clear INTRQ
     INTRQ = 0;
     ENGINT
                           // global interrupt enable
     DISGINT
                           // global interrupt disable
 }
void
        Interrupt (void)
                                 // interrupt service routine
  PUSHAF
                                 // store ALU and FLAG register
    // If INTEN.PA0 will be opened and closed dynamically,
    // user can judge whether INTEN.PA0 =1 or not.
     // Example: If (INTEN.PA0 && INTRQ.PA0) {...}
     // If INTEN.PA0 is always enable,
     // user can omit the INTEN.PA0 judgement to speed up interrupt service routine.
  If (INTRQ.PA0)
                                 // Here for PA0 interrupt service routine
  {
               INTRQ.PA0 = 0:
                                  // Delete corresponding bit (take PA0 for example)
  }
    //X: INTRQ = 0;
                             // It is not recommended to use INTRQ = 0 to clear all at the end of the
```



```
// interrupt service routine.

// It may accidentally clear out the interrupts that have just occurred

// and are not yet processed.

POPAF

// restore ALU and FLAG register

}
```

5.11. Power-Save and Power-Down

There are three operational modes defined by hardware: ON mode, Power-Save mode and Power-Down modes. ON mode is the state of normal operation with all functions ON, Power-Save mode ("stopexe") is the state to reduce operating current and CPU keeps ready to continue, Power-Down mode ("stopsys") is used to save power deeply. Therefore, Power-Save mode is used in the system which needs low operating power with wake-up occasionally and Power-Down mode is used in the system which needs power down deeply with seldom wake-up. Table 5 shows the differences in oscillator modules between Power-Save mode ("stopsys") and Power-Down mode ("stopsys").

Differences in oscillator modules between STOPSYS and STOPEXE				
	IHRC	ILRC	EOSC	
STOPSYS	Stop	Stop	Stop	
STOPEXE	No Change	No Change	No Change	

Table 5: Differences in oscillator modules between STOPSYS and STOPEXE

5.11.1 Power-Save mode ("stopexe")

Using "stopexe" instruction to enter the Power-Save mode, only system clock is disabled, remaining all the oscillator modules active. For CPU, it stops executing; however, for Timer16, counter keep counting if its clock source is not the system clock. Wake-up from input pins can be considered as a continuation of normal execution, the detail information for Power-Save mode shows below:

- IHRC and EOSC oscillator modules: No change, keep active if it was enabled.
- ILRC oscillator modules: must remain enabled, need to start with ILRC when be wakening up.
- System clock: Disable, therefore, CPU stops execution.
- OTP memory is turned off.
- Timer counter: Stop counting if its clock source is system clock or the corresponding oscillator module is disabled; otherwise, it keeps counting. (The Timer contains TM16, TM2, PWMG0, PWMG1, PWMG2.)
- Wake-up sources:
 - a. IO toggle wake-up: IO toggling in digital input mode (PxC bit is 1 and PxDIER bit is 1)
 - b. Timer wake-up: If the clock source of Timer is not the SYSCLK, the system will be awakened when the Timer counter reaches the set value.
 - c. Comparator wake-up: It need setting *GPCC*.7=1 and *GPCS*.6=1 to enable the comparator wake-up function at the same time.

An example shows how to use Timer16 to wake-up from "stopexe":

```
$ T16M | ILRC, /1, BIT8 | // Timer16 setting ...

WORD | count = 0;

STT16 | count;
```



stopexe;

...

The initial counting value of Timer16 is zero and the system will be woken up after the Timer16 counts 256 ILRC clocks.

5.11.2 Power-Down mode ("stopsys")

Power-Down mode is the state of deeply power-saving with turning off all the oscillator modules. By using the "stopsys" instruction, this chip will be put on Power-Down mode directly. It is recommend to set GPCC.7=0 to disable the comparator before the command "stopsys". The following shows the internal status of PMS152 detail when "stopsys" command is issued:

- All the oscillator modules are turned off.
- OTP memory is turned off.
- The contents of SRAM and registers remain unchanged.
- Wake-up sources: IO toggle in digital mode (PxDIER bit is 1)

Wake-up from input pins can be considered as a continuation of normal execution. To minimize power consumption, all the I/O pins should be carefully manipulated before entering power-down mode. The reference sample program for power down is shown as below:

```
CLKMD
                                   Change clock from IHRC to ILRC
                 0xF4;
                             //
CLKMD.4
                             //
                                   disable IHRC
                 0;
while (1)
           STOPSYS:
                             //
                                   enter power-down
           if (...) break;
                             //
                                   if wakeup happen and check OK, then return to high speed,
                                   else stay in power-down mode again
CLKMD
                             //
                                   Change clock from ILRC to IHRC/2
                 0x34;
```

5.11.3 Wake-up

After entering the Power-Down or Power-Save modes, the PMS152 can be resumed to normal operation by toggling IO pins. Wake-up from timer are available for Power-Save mode ONLY. Table 6 shows the differences in wake-up sources between STOPSYS and STOPEXE.

Differences	Differences in wake-up sources between STOPSYS and STOPEXE			
	IO Toggle	Timer wake-up		
STOPSYS	Yes	No		
STOPEXE	Yes	Yes		

Table 6: Differences in wake-up sources between Power-Save mode and Power-Down mode



When using the IO pins to wake-up the PMS152, registers *pxdier* should be properly set to enable the wake-up function for every corresponding pin. The time for normal wake-up is about 3000 ILRC clocks counting from wake-up event; fast wake-up can be selected to reduce the wake-up time by *misc* register, and the time for fast wake-up is about 45 ILRC clocks from IO toggling.

Suspend mode	Wake-up mode	Wake-up time (t _{WUP}) from IO toggle			
STOPEXE suspend		45 * T _{ILRC,}			
or	Fast wake-up				
STOPSYS suspend		where t _{ilenc} is the time period of ilenc			
STOPEXE suspend		Where T_{ILRC} is the time period of ILRC 3000 * T_{ILRC} ,			
or	Normal wake-up				
STOPSYS suspend		Where T _{ILRC} is the clock period of ILRC			

Table 7: Differences in wake-up time between Fast/Normal wake-up

Please notice that when Code Option is set to Fast boot-up, no matter which wake-up mode is selected in misc.5, the wake-up mode will be forced to be FAST. If Normal boot-up is selected, the wake-up mode is determined by misc.5.



5.12 IO Pins

All the pins can be independently set into two states output or input by configuring the data registers (*pa, pb*), control registers (*pac, pbc*) and pull-high resistor (*paph, pbph*). All these pins have Schmitt-trigger input buffer and output driver with CMOS level. When it is set to output low, the pull-high resistor is turned off automatically. If user wants to read the pin state, please notice that it should be set to input mode before reading the data port; if user reads the data port when it is set to output mode, the reading data comes from data register, NOT from IO pad. As an example, Table 8 shows the configuration table of bit 0 of port A. The hardware diagram of IO buffer is also shown as Fig.20.

pa.0	pac.0	paph.0	Description
Х	0	0	Input without pull-high resistor
Χ	0	1	Input with pull-high resistor
0	1	X	Output low without pull-high resistor
1	1	0	Output high without pull-high resistor
1	1	1	Output high with pull-high resistor

Table 8: PA0 Configuration Table

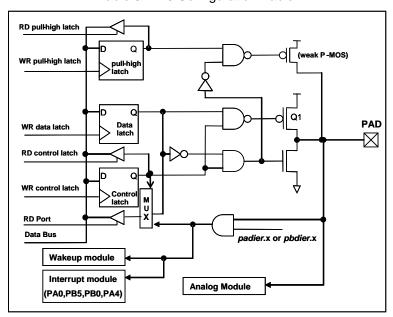


Fig.20: Hardware diagram of IO buffer

Other than PA5, all the IO pins have the same structure; PA5 can be open-drain ONLY when setting to output mode (without Q1). The corresponding bits in registers *padier* / *pbdier* should be set to low to prevent leakage current for those pins are selected to be analog function. When PMS152 is put in power-down or power-save mode, every pin can be used to wake-up system by toggling its state. Therefore, those pins needed to wake-up system must be set to input mode and set the corresponding bits of registers *padier* and *pbdier* to high. The same reason, *padier*.0 should be set high when PA0 is used as external interrupt pin, *pbdier*.0 for PB0, padier.4 for PA4 and *pbdier*.5 for PB5.



5.13 Reset and LVR

5.13.1 Reset

There are many causes to reset the PMS152, once reset is asserted, most of all the registers in PMS152 will be set to default values, system should be restarted once abnormal cases happen, or by jumping program counter to address 0x0. The data memory is in uncertain state when reset comes from power-up and LVR; however, the content will be kept when reset comes from PRSTB pin or WDT timeout.

5.13.2 LVR reset

By code option, there are 8 different levels of LVR for reset ~ 4.5V, 3.5V, 3.0V, 2.7V, 2.5V, 2.2V, 2.0V and 1.8V; usually, user selects LVR reset level to be in conjunction with operating frequency and supply voltage.



6. IO Registers

6.1. ACC Status Flag Register (flag), IO address = 0x00

Bit	Reset	R/W	Description
7 - 4	-	ı	Reserved. Please do not use.
3	0	R/W	OV (Overflow Flag). This bit is set to be 1 whenever the sign operation is overflow.
2	0	R/W	AC (Auxiliary Carry Flag). There are two conditions to set this bit, the first one is carry out of low nibble in addition operation and the other one is borrow from the high nibble into low nibble in subtraction operation.
1	0	R/W	C (Carry Flag). There are two conditions to set this bit, the first one is carry out in addition operation, and the other one is borrow in subtraction operation. Carry is also affected by shift with carry instruction.
0	0	R/W	Z (Zero Flag). This bit will be set when the result of arithmetic or logic operation is zero; Otherwise, it is cleared.

6.2. Stack Pointer Register (sp), IO address = 0x02

Bit	Reset	R/W	Description
7 - 0		R/W	Stack Pointer Register. Read out the current stack pointer, or write to change the stack
7 - 0	-	IX/VV	pointer.

6.3. Clock Mode Register (*clkmd*), IO address = 0x03

Bit	Reset	R/W	Desc	ription	
			System clock (CLK) selection:		
			Type 0, clkmd[3]=0	Type 1, clkmd[3]=1	
			000: IHRC÷4	000: IHRC÷16	
			001: IHRC÷2	001: IHRC÷8	
7 - 5	111	R/W	010: reserved	010: ILRC÷16 (ICE does NOT Support.)	
, ,		1011	011: EOSC÷4	011: IHRC÷32	
			100: EOSC÷2	100: IHRC÷64	
			101: EOSC	101: EOSC÷8	
			110: ILRC÷4	11x: reserved	
			111: ILRC (default)		
4	1	R/W	Internal High RC Enable. 0 / 1: disable / ena	ble	
3	0	0 R/W	Clock Type Select. This bit is used to select	the clock type in bit [7:5].	
3	U		0 / 1: Type 0 / Type 1		
2	1	R/W	Internal Low RC Enable. 0 / 1: disable / enat	ole	
		FX/ V V	If ILRC is disabled, watchdog timer is also di	isabled.	
1	1	R/W	Watch Dog Enable. 0 / 1: disable / enable		
0	0	R/W	Pin PA5/PRSTB function. 0 / 1: PA5 / PRSTB		



6.4. Interrupt Enable Register (inten), IO address = 0x04

Bit	Reset	R/W	Description
7	0	R/W	Reserved
6	0	R/W	Enable interrupt from Timer2. 0 / 1: disable / enable
5	0	R/W	Enable interrupt from PWMG. 0 / 1: disable / enable
4	0	R/W	Enable interrupt from comparator. 0 / 1: disable / enable
3	0	R/W	Reserved
2	0	R/W	Enable interrupt from Timer16 overflow. 0 / 1: disable / enable
1	0	R/W	Enable interrupt from PB0/PA4. 0 / 1: disable / enable
0	0	R/W	Enable interrupt from PA0/PB5. 0 / 1: disable / enable

6.5. Interrupt Request Register (intrq), IO address = 0x05

Bit	Reset	R/W	Description	
7	-	R/W	Reserved	
6		DAM	Interrupt Request from Timer2, this bit is set by hardware and cleared by software.	
6	-	R/W	0 / 1: No request / Request	
5		R/W	Interrupt Request from PWMG, this bit is set by hardware and cleared by software.	
5	-	R/VV	0 / 1: No request / Request	
4		- R/W	Interrupt Request from comparator, this bit is set by hardware and cleared by software.	
4	-		0 / 1: No request / Request	
3	-	R/W	Reserved	
2			DAM	Interrupt Request from Timer16, this bit is set by hardware and cleared by software.
	-	R/W	0 / 1: No request / Request	
1		DAM	Interrupt Request from pin PB0/PA4, this bit is set by hardware and cleared by software.	
I	-	R/W	0 / 1: No request / Request	
		DAM	Interrupt Request from pin PA0/PB5, this bit is set by hardware and cleared by software.	
0	-	R/W	0 / 1: No Request / request	



6.6. Timer16 mode Register (t16m), IO address = 0x06

Bit	Reset	R/W	Description
7 - 5	000	R/W	Timer16 Clock source selection. 000: disable 001: CLK (system clock) 010: reserved 011: PA4 falling edge (from external pin) 100: IHRC 101: EOSC 110: ILRC
			111: PA0 falling edge (from external pin)
4 - 3	00	R/W	Timer16 clock pre-divider. 00: ÷1 01: ÷4 10: ÷16 11: ÷64
2-0	000	R/W	Interrupt source selection. Interrupt event happens when the selected bit status is changed. 0: bit 8 of Timer16 1: bit 9 of Timer16 2: bit 10 of Timer16 3: bit 11 of Timer16 4: bit 12 of Timer16 5: bit 13 of Timer16 6: bit 14 of Timer16 7: bit 15 of Timer16

6.7. MISC Register (misc), IO address = 0x08

Bit	Reset	R/W	Description
7 - 6	-	-	Reserved. (keep 0 for future compatibility)
			Enable fast Wake up. Fast wake-up is NOT supported when EOSC is enabled.
			0: Normal wake up.
5	0	WO	The wake-up time is 3000 ILRC clocks (Not for fast boot-up)
			1: Fast wake up.
			The wake-up time is 45 ILRC clocks.
4	1	ı	Reserved.
3	1		Reserved.
	0	0 WO	Disable LVR function.
2	O		0 / 1 : Enable / Disable
			Watch dog time out period
			00: 8k ILRC clock period
1 - 0	00	WO	01: 16k ILRC clock period
			10: 64k ILRC clock period
			11: 256k ILRC clock period

Page 62 of 91



6.8. External Oscillator setting Register (eoscr), IO address = 0x0a

Bit	Reset	R/W	Description
7	0	WO	Enable external crystal oscillator. 0 / 1 : Disable / Enable
6 - 5	00	WO	External crystal oscillator selection. 00 : reserved 01 : Low driving capability, for lower frequency, ex: 32KHz crystal oscillator 10 : Middle driving capability, for middle frequency, ex: 1MHz crystal oscillator 11 : High driving capability, for higher frequency, ex: 4MHz crystal oscillator
4 - 1	-	-	Reserved. Please keep 0 for future compatibility.
0	0	WO	Power-down the Band-gap and LVR hardware modules. 0 / 1: normal / power-down.

6.9. Interrupt Edge Select Register (integs), IO address = 0x0c

Bit	Reset	R/W	Description
7 - 5	-	-	Reserved.
			Timer16 edge selection.
4	0	WO	0 : rising edge of the selected bit to trigger interrupt
			1 : falling edge of the selected bit to trigger interrupt
			PB0/PA4 edge selection.
			00: both rising edge and falling edge of the selected bit to trigger interrupt
3 - 2	00	WO	01: rising edge of the selected bit to trigger interrupt
			10: falling edge of the selected bit to trigger interrupt
			11: reserved.
			PA0/PB5 edge selection.
			00: both rising edge and falling edge of the selected bit to trigger interrupt
1 - 0	00	WO	01: rising edge of the selected bit to trigger interrupt
			10: falling edge of the selected bit to trigger interrupt
			11: reserved.

6.10. Port A Digital Input Enable Register (padier), IO address = 0x0d

Bit	Reset	R/W	Description
			Enable PA7 digital input and wake-up event. 1 / 0: enable / disable.
7	1	WO	This bit should be set to low to prevent leakage current when external crystal oscillator is
			used. If this bit is set to low, PA7 can NOT be used to wake-up the system.
			Enable PA6 digital input and wake-up event. 1 / 0: enable / disable.
6	1	WO	This bit should be set to low to prevent leakage current when external crystal oscillator is
			used. If this bit is set to low, PA6 can NOT be used to wake-up the system.
5	1	wo	Enable PA5 digital input and wake-up event. 1 / 0: enable / disable.
J	'	VVO	This bit can be set to low to disable wake-up from PA5 toggling.
	1	wo	Enable PA4 digital input, wake-up event and interrupt request. 1 / 0: enable / disable.
4			This bit should be set to low when PA4 is assigned as comparator input to prevent leakage
4			current. If this bit is set to low, PA4 can NOT be used to wake-up the system and interrupt
			from this pin is also disabled.
			Enable PA3 digital input and wake-up event. 1 / 0: enable / disable.
3	1	WO	This bit should be set to low when PA3 is assigned as comparator input to prevent leakage
			current. If this bit is set to low, PA3 can NOT be used to wake-up the system.
2 - 1	11	WO	Reserved
			Enable PA0 digital input and wake-up event and interrupt request. 1 / 0: enable / disable.
0	1	WO	This bit can be set to low to disable wake-up from PA0 toggling and interrupt request from
			this pin.



6.11. Port B Digital Input Enable Register (pbdier), IO address = 0x0e

Bit	Reset	R/W	Description
			Enable PB7~PB6 digital input and wake-up event. 1 / 0: enable / disable.
7 - 6	11	WO	The bit should be set to low when the pad is assigned as comparator input to prevent
			leakage current. If the bit is set to low, the pad can NOT be used to wake-up the system.
			Enable PB5 digital input and wake-up event and interrupt request. 1 / 0: enable / disable.
5	1	WO	This bit can be set to low to disable wake-up from PB5 toggling and interrupt request from
			this pin.
			Enable PB4~PB1 digital input and wake-up event. 1 / 0: enable / disable.
4 - 1	1111	WO	The bit should be set to low when the pad is assigned as comparator input to prevent
			leakage current. If the bit is set to low, the pad can NOT be used to wake-up the system.
			Enable PB0 digital input and wake-up event and interrupt request. 1 / 0: enable / disable.
0	1	WO	This bit can be set to low to disable wake-up from PB0 toggling and interrupt request from
			this pin.

6.12. Port A Data Register (pa), IO address = 0x10

Bit	Reset	R/W	Description
7 - 0	0x00	R/W	Data register for Port A.

6.13. Port A Control Register (pac), IO address = 0x11

Bit	Reset	R/W	Description
			Port A control registers. This register is used to define input mode or output mode for each
7 - 0	0x00	R/W	corresponding pin of port A. 0 / 1: input / output
			Please note: PA5 is an open drain output.

6.14. Port A Pull-High Register (paph), IO address = 0x12

Bit	Reset	R/W	Description
7 - 0	0x00	R/W	Port A pull-high register. This register is used to enable the internal pull-high device on each corresponding pin of port A and this pull high function is active only for input mode.
7 - 0	0,000	17/ 7 7	0 / 1 : disable / enable

6.15. Port B Data Register (pb), IO address = 0x14

Bit	Reset	R/W	Description
7 - 0	0x00	R/W	Data register for Port B.

6.16. Port B Control Register (pbc), IO address = 0x15

Bit	Reset	R/W	Description
7 - 0	0x00	R/W	Port B control register. This register is used to define input mode or output mode for each
7 - 0	UXUU		corresponding pin of port B. 0 / 1: input / output

Page 64 of 91



6.17. Port B Pull-High Register (pbph), IO address = 0x16

Bit	Reset	R/W	Description
7 - 0	0x00	R/W	Port B pull-high register. This register is used to enable the internal pull-high device on each corresponding pin of port B and this pull high function is active only for input mode.
' '	OXOO	10,00	0 / 1 : disable / enable

6.18. Comparator Control Register (qpcc), IO address = 0x18

0.10.	Oompo	Comparator Control Register (gpcc), 10 address = 0x10				
Bit	Reset	R/W	Description			
7	0	R/W	Enable comparator. 0 / 1 : disable / enable When this bit is set to enable, please also set the corresponding analog input pins to be digital disable to prevent IO leakage.			
6	-	RO	Comparator result of comparator. 0: plus input < minus input 1: plus input > minus input			
5	0	R/W	Select whether the comparator result output will be sampled by TM2_CLK? 0: result output NOT sampled by TM2_CLK 1: result output sampled by TM2_CLK			
4	0	R/W	Inverse the polarity of result output of comparator. 0: polarity is NOT inversed. 1: polarity is inversed.			
3 - 1	000	R/W	Selection the minus input (-) of comparator. 000: PA3 001: PA4 010: Internal 1.20 volt band-gap reference voltage 011: V _{internal R} 100: PB6 (ICE does NOT Support.) 101: PB7 (ICE does NOT Support.) 11X: reserved			
0	0	R/W	Selection the plus input (+) of comparator. 0: V _{internal R} 1: PA4			

6.19. Comparator Selection Register (gpcs), IO address = 0x19

	(3), 10 and 100 on 100			
Bit	Reset	R/W	Description	
			Comparator output enable (to PA0). 0 / 1 : disable / enable	
7	0	WO	(Please avoid this situation: GPCS will affect the PA3 output function when selecting output	
			to PA0 output in ICE.)	
6	0		Reserved	
5	0	WO	Selection of high range of comparator.	
4	0	WO	Selection of low range of comparator.	
0 0	0000		Selection the voltage level of comparator.	
3 - 0		WO	0000 (lowest) ~ 1111 (highest)	



6.20. Timer2 Control Register (tm2c), IO address = 0x1c

Bit	Reset	R/W	Description
7 - 4	0000	R/W	Timer2 clock selection. 0000: disable 0001: CLK (system clock) 0010: IHRC or IHRC *2 (by code option TM2_source) (ICE doesn't support IHRC *2.) 0011: EOSC 0100: ILRC 0101: comparator output 011x: reserved 1000: PA0 (rising edge) 1001: ~PA0 (falling edge) 1010: PB0 (rising edge) 1011: ~PB0 (falling edge) 1100: PA4 (rising edge) 1100: PA4 (fising edge) 1101: ~PA4 (falling edge) Motice: In ICE mode and IHRC is selected for Timer2 clock, the clock sent to Timer2 does NOT be stopped, Timer2 will keep counting when ICE is in halt state.
3 - 2	00	R/W	Timer2 output selection. 00 : disable 01 : PB2 10 : PA3 11 : PB4
1	0	R/W	TM2 Mode 0: Period Mode 1: PWM Mode
0	0	R/W	Inverse the polarity of result output of TM2. 0: polarity is NOT inversed. 1: polarity is inversed.

6.21. Timer2 Scalar Register (tm2s), IO address = 0x17

Bit	Reset	R/W	Description
			PWM resolution selection.
7	0	WO	0:8-bit
			1 : 6-bit or 7-bit (by code option TM2_bit) (ICE doesn't support 7-bit.)
			Timer2 clock pre-scalar.
			00 : ÷ 1
6 - 5	00	WO	01 : ÷ 4
			10 : ÷ 16
			11 : ÷ 64
4 - 0	00000	WO	Timer2 clock scalar.



6.22. Timer2 Counter Register (tm2ct), IO address = 0x1d

Bit	Reset	R/W	Description
7 - 0	0x00	R/W	Bit [7:0] of Timer2 counter register.

6.23. Timer2 Bound Register (tm2b), IO address = 0x09

Bit	Reset	R/W	Description
7 - 0	0x00	WO	Timer2 bound register.

6.24. PWMG0 control Register (pwmg0c), IO address = 0x20

Bit	Reset	R/W	Description
7	-	-	Reserved.
6	-	RO	Output status of PWMG0 generator.
5	0	WO	Enable to inverse the polarity of PWMG0 generator output. 0 / 1: disable / enable.
4	0	WO	PWMG0 output selection. 0: PWMG0 Output 1: PWMG0 XOR PWMG1 or PWMG0 OR PWMG1 (by pwmg0c.0)
3-1	000	R/W	PWMG0 Output Port Selection 000: PWMG0 Output Disable 001: PWMG0 Output to PB5 010: Reserved 011: PWMG0 Output to PA0 100: PWMG0 Output to PB4 1xx: Reserved
0	0	R/W	PWMG0 output pre- selection. 0: PWMG0 XOR PWMG1 1: PWMG0 OR PWMG1



6.25. PWMG Clock Register (pwmgclk), IO address = 0x21

Bit	Reset	R/W	Description
7	0	wo	PWMG Disable/ Enable 0: PWMG Disable 1: PWMG Enable
6 - 4	000	wo	PWMG clock pre-scalar. 000: ÷1 001: ÷2 010: ÷4 011: ÷8 100: ÷16 101: ÷32 110: ÷64 111: ÷128
3 - 1	-	1	Reserved
0	0	wo	PWMG clock source selection 0: System Clock 1: IHRC or IHRC*2 (by code option PWM_Source)

6.26. PWMG0 Duty Value High Register (pwmg0dth), IO address = 0x22

Bit	Reset	R/W	Description
7 - 0	-	WO	Bit[10:3] of PWMG0 Duty.

6.27. PWMG0 Duty Value Low Register (pwmg0dtl), IO address = 0x23

Bit	Reset	R/W	Description
7 - 5	-	WO	Bit[2:0] of PWMG0 Duty.
4 - 0	-	-	Reserved

Note: It's necessary to write PWMG0 Duty_Value Low Register before writing PWMG0 Duty_Value High Register.

6.28. PWMG Counter Upper Bound High Register (pwmgcubh), IO address = 0x24

Bit	Reset	R/W	Description
7 - 0	-	WO	Bit[10:3] of PWMG Counter Bound.

6.29. PWMG Counter Upper Bound Low Register (pwmgcubl), IO address = 0x25

Bit	Reset	R/W	Description
7 - 6	-	WO	Bit[2:1] of PWMG Counter Bound.
5 - 0	-	-	Reserved



6.30. PWMG1 control Register (pwmg1c), IO address = 0x26

Bit	Reset	R/W	Description
7	-	-	Reserved
6	-	RO	Output status of PWMG1 generator
5	0	R/W	Enable to inverse the polarity of PWMG1 generator output. 0 / 1: disable / enable.
4	0	R/W	PWMG1 output selection: 0: PWMG1 1: PWMG2
3 - 1	000	R/W	PWMG1 Output Port Selection: 000: PWMG1 Output Disable 001: PWMG1 Output to PB6 010: Reserved 011: PWMG0 Output to PA4 100: PWMG0 Output to PB7 1xx: Reserved
0	-	R/W	Reserved

6.31. PWMG1 Duty Value High Register (pwmg1dth), IO address = 0x28

Bit	Reset	R/W	Description
7 - 0	-	WO	Bit[10:3] of PWMG1 Duty

6.32. PWMG1 Duty Value Low Register (pwmg1dtl), IO address = 0x29

Bit	Reset	R/W	Description
7 - 5	-	WO	Bit[2:0] of PWMG1 Duty.
4 - 0	-	-	Reserved

Note: It's necessary to write PWMG1 Duty_Value Low Register before writing PWMG1 Duty_Value High Register.



6.33. PWMG2 control Register (pwmg2c), IO address = 0x2C

Bit	Reset	R/W	Description	
7	-	-	Reserved.	
6	-	RO	Output status of PWMG2 generator.	
5	0	R/W	Enable to inverse the polarity of PWMG2 generator output. 0 / 1: disable / enable.	
4	0	R/W	PWMG2 output selection: 0: PWMG2 1: PWMG2 ÷2	
3 - 1	000	R/W	PWMG2 Output Port Selection: 000: PWMG2 Output Disable 001: PWMG2 Output to PB3 010: Reserved 011: PWMG2 Output to PA3 100: PWMG2 Output to PB2 101: PWMG2 Output to PA5 1xx: Reserved	
0	-	R/W	Reserved	

6.34. PWMG2 Duty Value High Register (pwmg2dth), IO address = 0x2E

			<u> </u>	'	 7.
Bit	Reset	R/W			Description
7 - 0	-	WO	Bit[10:3] of PWMG2 Duty		

6.35. PWMG2 Duty Value Low Register (pwmg2dtl), IO address = 0x2F

Bit	Reset	R/W	Description
7 - 5	-	WO	Bit[2:0] of PWMG2 Duty
4 - 0	-	-	Reserved

Note: It's necessary to write PWMG2 Duty_Value Low Register before writing PWMG2 Duty_Value High Register.



7. Instructions

Symbol	Description			
ACC	Accumulator (Abbreviation of accumulator)			
а	Accumulator (symbol of accumulator in program)			
sp	Stack pointer			
flag	ACC status flag register			
ı	Immediate data			
&	Logical AND			
I	Logical OR			
←	Movement			
^	Exclusive logic OR			
+	Add			
_	Subtraction			
~	NOT (logical complement, 1's complement)			
₹	NEG (2's complement)			
ov	Overflow (The operational result is out of range in signed 2's complement number system)			
Z	Zero (If the result of ALU operation is zero, this bit is set to 1)			
С	Carry (The operational result is to have carry out for addition or to borrow carry for subtraction in			
	unsigned number system)			
AC	Auxiliary Carry			
AU	(If there is a carry out from low nibble after the result of ALU operation, this bit is set to 1)			
M.n	Only addressed in 0~0x3F (0~63) is allowed			
IO.n	Only addressed in 0~0x3F (0~63) is allowed			



7.1. Data Transfer Instructions

mov	a, I Move immediate data into ACC.			
		Example: mov a, 0x0f;		
		Result: $a \leftarrow 0 fh$;		
		Affected flags: 『N』Z 『N』C 『N』AC 『N』OV		
mov	М, а	Move data from ACC into memory		
		Example: mov MEM, a;		
		Result: MEM ← a		
		Affected flags: 『N』Z 『N』C 『N』AC 『N』OV		
mov	a, M	Move data from memory into ACC		
		Example: mov a, MEM;		
		Result: a ← MEM; Flag Z is set when MEM is zero.		
		Affected flags: "Y』Z "N』C "N』AC "N』OV		
mov	a, IO	Move data from IO into ACC		
	,	Example: mov a, pa;		
		Result: a ← pa; Flag Z is set when pa is zero.		
		Affected flags: "Y"Z "N"C "N"AC "N"OV		
mov	IO, a	Move data from ACC into IO		
	•	Example: mov pb, a;		
		Result: pb ← a		
		Affected flags: "N,Z "N,C "N,AC "N,OV		
ldt16	word	Move 16-bit counting values in Timer16 to memory in word.		
		Example: Idt16 word;		
		Result: word ← 16-bit timer		
		Affected flags: "N』Z "N』C "N』AC "N』OV		
		Application Example:		
		word T16val; // declare a RAM word		
		clear lb@ T16val; // clear T16val (LSB)		
		clear hb@ T16val; // clear T16val (MSB)		
		stt16 T16val; // initial T16 with 0		
		miniative marc		
		set1 t16m.5; // enable Timer16		
		set0 t16m.5; // disable Timer 16		
		Idt16 T16val; // save the T16 counting value to T16val		



stt16 word	Store 16-bit data from memory in word to Timer16.
	Example: stt16 word;
	Result: 16-bit timer ←word
	Affected flags: "N』Z "N』C "N』AC "N』OV
	Application Example:
	word T16val; // declare a RAM word
	mov a, 0x34;
	mov lb@ T16val , a; // move 0x34 to T16val (LSB) mov a, 0x12;
	mov a, 0x12; mov hb@ T16val, a; // move 0x12 to T16val (MSB)
	stt16 T16val; // initial T16 with 0x1234
	31170 1 10Val , // Illittal 1 10 With 0X1234
idxm a, index	Move data from specified memory to ACC by indirect method. It needs 2T to execute this
,	instruction.
	Example: idxm a, index;
	Result: a ← [index], where index is declared by word.
	Affected flags: 『N』Z 『N』C 『N』AC 『N』OV
	Assiliantia E anni
	Application Example:
	word RAMIndex; // declare a RAM pointer
	mov a, 0x5B; // assign pointer to an address (LSB)
	mov lb@RAMIndex, a; // save pointer to RAM (LSB)
	mov a, 0x00; // assign 0x00 to an address (MSB), should be 0
	mov hb@RAMIndex, a; // save pointer to RAM (MSB)
	···
	idxm a, RAMIndex; // mov memory data in address 0x5B to ACC

Idxm index, a	Move data from ACC to specified memory by indirect method. It needs 2T to execute this instruction. Example: idxm index, a; Result: [index] ← a; where index is declared by word. Affected flags: 『N』Z 『N』C 『N』AC 『N』OV Application Example:		
	word RAMIndex; // declare a RAM pointer		
	mova, 0x5B;// assign pointer to an address (LSB)movlb@RAMIndex, a;// save pointer to RAM (LSB)mova, 0x00;// assign 0x00 to an address (MSB), should be 0movhb@RAMIndex, a;// save pointer to RAM (MSB)		
	mov a, 0xA5; idxm RAMIndex, a; // mov 0xA5 to memory in address 0x5B		
xch M	Exchange data between ACC and memory Example: xch MEM; Result: MEM ← a , a ← MEM Affected flags: 『N』Z 『N』C 『N』AC 『N』OV		
pushaf	Move the <i>ACC</i> and <i>flag</i> register to memory that address specified in the stack pointer. Example: <i>pushaf</i> ; Result: [sp] ← {flag, ACC}; sp ← sp + 2; Affected flags: 『N』Z 『N』C 『N』AC 『N』OV		
	.romadr 0x10; // ISR entry address pushaf; // put ACC and flag into stack memory // ISR program // ISR program popaf; // restore ACC and flag from stack memory reti;		
popaf	Restore <i>ACC</i> and <i>flag</i> from the memory which address is specified in the stack pointer. Example: <i>popaf</i> ; Result: sp ← sp - 2 ; {Flag, ACC} ← [sp] ; Affected flags: 『Y』Z 『Y』C 『Y』AC 『Y』OV		



7.2. Arithmetic Operation Instructions

7.2. Arithn	netic Operation instructions
add a, I	Add immediate data with ACC, then put result into ACC
	Example: add a, 0x0f;
	Result: a ← a + 0fh
	Affected flags: "Y』Z "Y』C "Y』AC "Y』OV
add a, M	Add data in memory with ACC, then put result into ACC
ada a, m	Example: add a, MEM;
	Result: a ← a + MEM
	Affected flags: "Y Z "Y C "Y AC "Y OV
add M, a	Add data in memory with ACC, then put result into memory
	Example: add MEM, a;
	Result: MEM ← a + MEM
	Affected flags: "Y Z "Y C "Y AC "Y OV
<i>addc</i> a, M	Add data in memory with ACC and carry bit, then put result into ACC
	Example: addc a, MEM;
	Result: a ← a + MEM + C
	Affected flags: 『Y』Z 『Y』C 『Y』AC 『Y』OV
addc M, a	Add data in memory with ACC and carry bit, then put result into memory
	Example: addc MEM, a;
	Result: MEM ← a + MEM + C
	Affected flags: 『Y』Z 『Y』C 『Y』AC 『Y』OV
addc a	Add carry with ACC, then put result into ACC
	Example: addc a;
	Result: a ← a + C
	Affected flags: "Y_Z "Y_C "Y_AC "Y_OV
addc M	Add carry with memory, then put result into memory
addo III	Example: addc MEM;
	Result: MEM ← MEM + C
	Affected flags: "Y_Z "Y_C "Y_AC "Y_OV
model o M	
nadd a, M	Add negative logic (2's complement) of ACC with memory
	Example: nadd a, MEM;
	Result: a ← 〒a + MEM
	Affected flags: 『Y』Z 『Y』C 『Y』AC 『Y』OV
	Allected liags.
<i>nadd</i> M, a	Add negative logic (2's complement) of memory with ACC
	Example: nadd MEM, a ;
	Result: MEM ← 〒MEM + a
	·
	Affected flags: 『Y』Z 『Y』C 『Y』AC 『Y』OV
sub a, I	Subtraction immediate data from ACC, then put result into ACC.
	Example: sub a, 0x0f;
	Result: a ← a - 0fh (a + [2's complement of 0fh])
	Affected flags: 『Y』Z 『Y』C 『Y』AC 『Y』OV
sub a, M	Subtraction data in memory from ACC, then put result into ACC
	Example: sub a, MEM;
	Result: a ← a - MEM (a + [2's complement of M])
	Affected flags: 『Y』Z 『Y』C 『Y』AC 『Y』OV



sub M, a	Subtraction data in ACC from memory, then put result into memory
	Example: sub MEM, a;
	Result: MEM ← MEM - a (MEM + [2's complement of a])
	Affected flags: 『Y』Z 『Y』C 『Y』AC 『Y』OV
subc a, M	Subtraction data in memory and carry from ACC, then put result into ACC
	Example: subc a, MEM;
	Result: a ← a – MEM - C
	Affected flags: 『Y』Z 『Y』C 『Y』AC 『Y』OV
subc M, a	Subtraction ACC and carry bit from memory, then put result into memory
	Example: subc MEM, a;
	Result: MEM ← MEM – a - C
	Affected flags: "Y』Z "Y』C "Y』AC "Y』OV
subc a	Subtraction carry from ACC, then put result into ACC
	Example: subc a;
	Result: a ← a - C
	Affected flags: 『Y』Z 『Y』C 『Y』AC 『Y』OV
subc M	Subtraction carry from the content of memory, then put result into memory
	Example: subc MEM;
	Result: MEM ← MEM - C
	Affected flags: 『Y』Z 『Y』C 『Y』AC 『Y』OV
inc M	Increment the content of memory
	Example: inc MEM;
	Result: MEM ← MEM + 1
	Affected flags: 『Y』Z 『Y』C 『Y』AC 『Y』OV
dec M	Decrement the content of memory
	Example: dec MEM;
	Result: MEM ← MEM - 1
	Affected flags: 『Y』Z 『Y』C 『Y』AC 『Y』OV
clear M	Clear the content of memory
	Example: clear MEM;
	Result: MEM ← 0
	Affected flags: 『N』Z 『N』C 『N』AC 『N』OV



7.3. Shift Operation Instructions

<i>sr</i> a	Shift right of ACC, shift 0 to bit 7
	Example: sr a;
	Result: a (0,b7,b6,b5,b4,b3,b2,b1) ← a (b7,b6,b5,b4,b3,b2,b1,b0), C ← a(b0)
	Affected flags: 『N』Z 『Y』C 『N』AC 『N』OV
src a	Shift right of ACC with carry bit 7 to flag
	Example: src a;
	Result: $a(c,b7,b6,b5,b4,b3,b2,b1) \leftarrow a(b7,b6,b5,b4,b3,b2,b1,b0), C \leftarrow a(b0)$
	Affected flags: 『N』Z 『Y』C 『N』AC 『N』OV
sr M	Shift right the content of memory, shift 0 to bit 7
	Example: sr MEM;
	Result: $MEM(0,b7,b6,b5,b4,b3,b2,b1) \leftarrow MEM(b7,b6,b5,b4,b3,b2,b1,b0), C \leftarrow MEM(b0)$
	Affected flags: 『N』Z 『Y』C 『N』AC 『N』OV
src M	Shift right of memory with carry bit 7 to flag
	Example: src MEM;
	Result: $MEM(c,b7,b6,b5,b4,b3,b2,b1) \leftarrow MEM(b7,b6,b5,b4,b3,b2,b1,b0), C \leftarrow MEM(b0)$
	Affected flags: 『N』Z 『Y』C 『N』AC 『N』OV
sI a	Shift left of ACC shift 0 to bit 0
	Example: sl a;
	Result: a (b6,b5,b4,b3,b2,b1,b0,0) ← a (b7,b6,b5,b4,b3,b2,b1,b0), C ← a (b7)
	Affected flags: 『N』Z 『Y』C 『N』AC 『N』OV
<i>slc</i> a	Shift left of ACC with carry bit 0 to flag
	Example: slc a;
	Result: a (b6,b5,b4,b3,b2,b1,b0,c) ← a (b7,b6,b5,b4,b3,b2,b1,b0), C ← a(b7)
	Affected flags: 『N』Z 『Y』C 『N』AC 『N』OV
s/ M	Shift left of memory, shift 0 to bit 0
	Example: sl MEM;
	Result: MEM (b6,b5,b4,b3,b2,b1,b0,0) ← MEM (b7,b6,b5,b4,b3,b2,b1,b0), C ← MEM(b7)
	Affected flags: 『N』Z 『Y』C 『N』AC 『N』OV
slc M	Shift left of memory with carry bit 0 to flag
	Example: slc MEM;
	Result: MEM (b6,b5,b4,b3,b2,b1,b0,C) ← MEM (b7,b6,b5,b4,b3,b2,b1,b0), C ← MEM (b7)
	Affected flags: 『N』Z 『Y』C 『N』AC 『N』OV
swap a	Swap the high nibble and low nibble of ACC
	Example: swap a;
	Result: a (b3,b2,b1,b0,b7,b6,b5,b4) ← a (b7,b6,b5,b4,b3,b2,b1,b0)
	Affected flags: 『N』Z 『N』C 『N』AC 『N』OV



7.4. Logic Operation Instructions

	peration instructions
and a, I	Perform logic AND on ACC and immediate data, then put result into ACC
	Example: and a, 0x0f;
	Result: a ← a & 0fh
	Affected flags: 『Y』Z 『N』C 『N』AC 『N』OV
and a, M	Perform logic AND on ACC and memory, then put result into ACC
	Example: and a, RAM10;
	Result: a ← a & RAM10
	Affected flags: 『Y』Z 『N』C 『N』AC 『N』OV
and M, a	Perform logic AND on ACC and memory, then put result into memory
	Example: and MEM, a;
	Result: MEM ← a & MEM
	Affected flags: 『Y』Z 『N』C 『N』AC 『N』OV
or a, I	Perform logic OR on ACC and immediate data, then put result into ACC
	Example: or a, 0x0f;
	Result: a ← a 0fh
	Affected flags: 『Y』Z 『N』C 『N』AC 『N』OV
or a, M	Perform logic OR on ACC and memory, then put result into ACC
	Example: or a, MEM;
	Result: a ← a MEM
	Affected flags: 『Y』Z 『N』C 『N』AC 『N』OV
or M, a	Perform logic OR on ACC and memory, then put result into memory
	Example: or MEM, a;
	Result: MEM ← a MEM
	Affected flags: 『Y』Z 『N』C 『N』AC 『N』OV
xor a, I	Perform logic XOR on ACC and immediate data, then put result into ACC
	Example: xor a, 0x0f;
	Result: a ← a ^ 0fh
	Affected flags: 『Y』Z 『N』C 『N』AC 『N』OV
xor IO, a	Perform logic XOR on ACC and IO register, then put result into IO register
	Example: xor pa, a;
	Result: pa ← a ^ pa ; // pa is the data register of port A
	Affected flags: "N ₂ Z "N ₂ C "N ₃ AC "N ₃ OV
xor a, M	Perform logic XOR on ACC and memory, then put result into ACC
xor a, M	Example: xor a, MEM;
	Result: a ← a ^ RAM10
vor M.s	Affected flags: "Y Z "N C "N AC "N OV
xor M, a	Perform logic XOR on ACC and memory, then put result into memory
	Example: xor MEM, a;
	Result: MEM ← a ^ MEM
	Affected flags: 『Y』Z 『N』C 『N』AC 『N』OV

not a	Perform 1's complement (logical complement) of ACC Example: not a; Result: a ← ~a Affected flags: 『Y』Z 『N』C 『N』AC 『N』OV Application Example: mov a, 0x38; // ACC=0X38 not a; // ACC=0XC7
not M	Perform 1's complement (logical complement) of memory Example: not MEM; Result: MEM ← ~MEM Affected flags: 『Y』Z 『N』C 『N』AC 『N』OV Application Example: mov a, 0x38; mov mem, a; // mem = 0x38 not mem; // mem = 0xC7
neg a	Perform 2's complement of ACC Example: neg a; Result: a ← 〒a Affected flags: 『Y』Z 『N』C 『N』AC 『N』OV Application Example: mov a, 0x38; // ACC=0X38 neg a; // ACC=0XC8
neg M	Perform 2's complement of memory Example: neg MEM; Result: MEM ← 〒MEM Affected flags: 『Y』Z 『N』C 『N』AC 『N』OV Application Example: mov a, 0x38; mov mem, a; // mem = 0x38 not mem; // mem = 0xC8

comp a, M	Compare AC	C with the content of memory		
		Example: comp a, MEM;		
		Result: Flag	will be changed by regarding as (a - MEM)	
		Affected flags	s: 『Y』Z 『Y』C 『Y』AC 『Y』OV	
		Application E		
		mov	a, 0x38 ;	
		mov	mem, a ;	
		comp	a, mem ; // Z flag is set as 1	
		mov	a, 0x42 ;	
		mov	mem, a ;	
		mov	a, 0x38 ;	
		comp	a, mem ; // C flag is set as 1	
сотр М	1, a	Compare AC	C with the content of memory	
		Example: c	omp MEM, a;	
		Result: Flag	will be changed by regarding as (MEM - a)	
		Affected flags	s: 『Y』Z 『Y』C 『Y』AC 『Y』OV	



7.5. Bit Operation Instructions

7.5. Bit Open	ation instructions			
set0 IO.n	Set bit n of IO port to low			
	Example: set0 pa.5;			
	Result: set bit 5 of port A to low			
	Affected flags: 『N』Z 『N』C 『N』AC 『N』OV			
set1 IO.n	Set bit n of IO port to high			
	Example: set1 pb.5;			
	Result: set bit 5 of port B to high			
	Affected flags: 『N』Z 『N』C 『N』AC 『N』OV			
<i>swapc</i> IO.n	Swap the nth bit of IO port with carry bit			
	Example: swapc IO.0;			
	Result: $C \leftarrow IO.0$, $IO.0 \leftarrow C$			
	When IO.0 is a port to output pin, carry C will be sent to IO.0;			
	When IO.0 is a port from input pin, IO.0 will be sent to carry C;			
	Affected flags: 『N』Z 『Y』C 『N』AC 『N』OV			
	Application Example1 (serial output):			
	set1 pac.0; // set PA.0 as output			
	set0 flag.1; // C=0			
	swapc pa.0; // move C to PA.0 (bit operation), PA.0=0			
	set1 flag.1; // C=1			
	swapc pa.0; // move C to PA.0 (bit operation), PA.0=1			
	Application Example2 (serial input):			
	set0 pac.0; // set PA.0 as input			
	swapc pa.0; // read PA.0 to C (bit operation)			
	src a; // shift C to bit 7 of ACC			
	swapc pa.0; // read PA.0 to C (bit operation)			
	src a; // shift new C to bit 7, old C			
set0 M.n	Set bit n of memory to low			
	Example: set0 MEM.5;			
	Result: set bit 5 of MEM to low			
	Affected flags: 『N』Z 『N』C 『N』AC 『N』OV			
set1 M.n	Set bit n of memory to high			
	Example: set1 MEM.5;			
	Result: set bit 5 of MEM to high			
	Affected flags: 『N』Z 『N』C 『N』AC 『N』OV			



7.6. Conditional Operation Instructions

ceqsn a, I	Compare ACC with immediate data and skip next instruction if both are equal.
	Flag will be changed like as (a ← a − I)
	Example: ceqsn a, 0x55;
	inc MEM;
	goto error;
	Result: If a=0x55, then "goto error"; otherwise, "inc MEM".
	Affected flags: "Y Z "Y C "Y AC "Y OV
ceqsn a, M	Compare ACC with memory and skip next instruction if both are equal.
	Flag will be changed like as (a ← a - M)
	Example: ceqsn a, MEM;
	Result: If a=MEM, skip next instruction
	Affected flags: "Y Z "Y C "Y AC "Y OV
cneqsn a, M	Compare ACC with memory and skip next instruction if both are not equal.
	Flag will be changed like as (a ← a - M)
	Example: cneqsn a, MEM;
	Result: If a≠MEM, skip next instruction
	Affected flags: "Y Z "Y C "Y AC "Y OV
cneqsn a, I	Compare ACC with immediate data and skip next instruction if both are no equal.
, ,	Flag will be changed like as (a ← a - I)
	Example: cneqsn a,0x55;
	inc MEM;
	goto error;
	Result: If a≠0x55, then "goto error"; Otherwise, "inc MEM".
	Affected flags: "Y』Z "Y』C "Y』AC "Y』OV
t0sn IO.n	Check IO bit and skip next instruction if it's low
	Example: t0sn pa.5;
	Result: If bit 5 of port A is low, skip next instruction
	Affected flags: "N』Z "N』C "N』AC "N』OV
t1sn IO.n	Check IO bit and skip next instruction if it's high
	Example: t1sn pa.5;
	Result: If bit 5 of port A is high, skip next instruction
	Affected flags: "N_Z "N_C "N_AC "N_OV
<i>t0sn</i> M.n	Check memory bit and skip next instruction if it's low
	Example: tOsn MEM.5;
	Result: If bit 5 of MEM is low, then skip next instruction
	Affected flags: "N Z "N C "N AC "N OV
<i>t1sn</i> M.n	Check memory bit and skip next instruction if it's high
	EX: t1sn MEM.5;
	Result: If bit 5 of MEM is high, then skip next instruction
	Affected flags: 『N』Z 『N』C 『N』AC 『N』OV
izsn a	Increment ACC and skip next instruction if ACC is zero
	Example: izsn a;
	Result: a ← a + 1,skip next instruction if a = 0 Affected flags: 『Y』Z 『Y』C 『Y』AC 『Y』OV
	I ATTOCTOG TIOGC: UV / UV



dzsn a	Decrement ACC and skip next instruction if ACC is zero
	Example: dzsn a;
	Result: $A \leftarrow A - 1$, skip next instruction if $a = 0$
	Affected flags: "Y』Z "Y』C "Y』AC "Y』OV
izsn M	Increment memory and skip next instruction if memory is zero
	Example: izsn MEM;
	Result: MEM ← MEM + 1, skip next instruction if MEM= 0
	Affected flags: "Y』Z "Y』C "Y』AC "Y』OV
dzsn M	Decrement memory and skip next instruction if memory is zero
	Example: dzsn MEM;
	Result: MEM ← MEM - 1, skip next instruction if MEM = 0
	Affected flags: "Y』Z "Y』C "Y』AC "Y』OV

7.7. System control Instructions

i.i. System	Control instructions
call label	Function call, address can be full range address space
	Example: call function1;
	Result: [sp] ← pc + 1
	pc ← function1
	sp ← sp + 2
	Affected flags: 『N』Z 『N』C 『N』AC 『N』OV
goto label	Go to specific address which can be full range address space
	Example: goto error;
	Result: Go to error and execute program.
	Affected flags: 『N』Z 『N』C 『N』AC 『N』OV
ret I	Place immediate data to ACC, then return
	Example: ret 0x55;
	Result: A ← 55h
	ret;
	Affected flags: 『N』Z 『N』C 『N』AC 『N』OV
ret	Return to program which had function call
	Example: ret;
	Result: sp ← sp - 2
	pc ← [sp]
	Affected flags: 『N』Z 『N』C 『N』AC 『N』OV
reti	Return to program that is interrupt service routine. After this command is executed, global
	interrupt is enabled automatically.
	Example: reti;
	Affected flags: 『N』Z 『N』C 『N』AC 『N』OV
nop	No operation
	Example: nop;
	Result: nothing changed
	Affected flags: 『N』Z 『N』C 『N』AC 『N』OV
wdreset	Reset Watchdog timer.
	Example: wdreset;
	Result: Reset Watchdog timer.
	Affected flags: 『N』Z 『N』C 『N』AC 『N』OV

pcadd a	Next program counter is current program counter plus ACC.							
,	Example: pcadd a;							
	Result: pc ← pc + a							
	Affected flags: 『N』Z 『N』C 『N』AC 『N』OV							
	Application Example:							
	mov a, 0x02 ;							
	pcadd a; // PC <- PC+2							
	goto err1;							
	goto correct; // jump here							
	goto err2;							
	goto err3;							
	correct: // jump here							
engint	Enable global interrupt enable							
	Example: engint;							
	Result: Interrupt request can be sent to FPP0							
	Affected flags: 『N』Z 『N』C 『N』AC 『N』OV							
disgint	Disable global interrupt enable							
	Example: disgint;							
	Result: Interrupt request is blocked from CPU							
	Affected flags: 『N』Z 『N』C 『N』AC 『N』OV							
stopsys	System halt.							
	Example: stopsys;							
	Result: Stop the system clocks and halt the system							
	Affected flags: 『N』Z 『N』C 『N』AC 『N』OV							
stopexe	CPU halt. The oscillator module is still active to output clock, however, system clock is disabled							
	to save power.							
	Example: stopexe;							
	Result: Stop the system clocks and keep oscillator modules active.							
	Affected flags: 『N』Z 『N』C 『N』AC 『N』OV							
reset	Reset the whole chip, its operation will be same as hardware reset.							
	Example: reset,							
	Result: Reset the whole chip.							
	Affected flags: 『N』Z 『N』C 『N』AC 『N』OV							

7.8. Summary of Instructions Execution Cycle

2T		goto, call, idxm, pcadd, ret, reti			
2T	Condition is fulfilled	agen energy than then dran iron			
1T	Condition is not fulfilled	ceqsn, cneqsn,t0sn, t1sn, dzsn, izsn			
1T		Others			



7.9. Summary of affected flags by Instructions

Instruction	Z	С	AC	ov	Instruction	Z	С	AC	ov	Instruction	Z	С	AC	ov
mov a, I	-	-	-	-	mov M, a	ı	-	-	-	mov a, M	Υ	-	-	-
mov a, IO	Υ	-	-	-	mov IO, a	-	-	-	-	<i>ldt16</i> word	-	-	-	-
stt16 word	-	-	-	-	idxm a, index	-	-	-	-	idxm index, a	-	-	-	-
xch M	-	-	-	-	pushaf	-	-	-	-	popaf	Υ	Υ	Υ	Υ
add a, I	Υ	Υ	Υ	Υ	add a, M	Υ	Υ	Υ	Υ	add M, a	Υ	Υ	Υ	Υ
addc a, M	Υ	Υ	Υ	Υ	addc M, a	Υ	Υ	Υ	Υ	addc a	Υ	Υ	Υ	Υ
addc M	Υ	Υ	Υ	Υ	sub a, I	Υ	Υ	Υ	Υ	sub a, M	Υ	Υ	Υ	Υ
sub M, a	Υ	Υ	Υ	Υ	subc a, M	Υ	Υ	Υ	Υ	subc M, a	Υ	Υ	Υ	Υ
subc a	Υ	Υ	Υ	Υ	subc M	Υ	Υ	Υ	Υ	inc M	Υ	Υ	Υ	Υ
dec M	Υ	Υ	Υ	Υ	clear M	ı	-	-	-	sr a	-	Υ	-	-
src a	-	Υ	-	-	sr M	ı	Υ	-	-	src M	-	Υ	-	-
s/ a	-	Υ	-	-	slc a	-	Υ	-	-	s/ M	-	Υ	-	-
slc M	-	Υ	-	-	swap a	-	-	-	-	and a, I	Υ	-	-	-
and a, M	Υ	-	-	-	and M, a	Υ	-	-	-	or a, I	Υ	-	-	-
or a, M	Υ	-	-	-	or M, a	Υ	-	-	-	xor a, I	Υ	-	-	-
xor IO, a	-	-	-	-	xor a, M	Υ	-	-	-	xor M, a	Υ	-	-	-
not a	Υ	-	-	-	not M	Υ	-	-	-	neg a	Υ	-	-	-
neg M	Υ	-	-	-	set0 IO.n	ı	-	-	-	set1 IO.n	-	-	-	-
set0 M.n	-	-	-	-	set1 M.n	-	-	-	-	ceqsn a, I	Υ	Υ	Υ	Υ
ceqsn a, M	Υ	Υ	Υ	Υ	t0sn IO.n	-	-	-	-	t1sn IO.n	-	-	-	-
t0sn M.n	-	-	-	-	<i>t1sn</i> M.n	-	-	-	-	izsn a	Υ	Υ	Υ	Υ
dzsn a	Υ	Υ	Υ	Υ	izsn M	Υ	Υ	Υ	Υ	dzsn M	Υ	Υ	Υ	Υ
call label	-	-	-	-	goto label	-	-	-	-	ret I	-	-	-	-
ret	-	-	-	-	reti	-	-	-	-	пор	-	-	-	-
pcadd a	-	-	-	-	engint	-	-	-	-	disgint	-	-	-	-
stopsys	-	-	-	-	stopexe	-	-	-	-	reset	-	-	-	-
wdreset	-	-	-	-	nadd M, a	Υ	Υ	Υ	Υ	cneqsn a, I	Υ	Υ	Υ	Υ
cneqsn a, M	Υ	Υ	Υ	Υ	comp a, M	Υ	Υ	Υ	Υ	nadd a, M	Υ	Υ	Υ	Υ
comp M, a	Υ	Υ	Υ	Υ	swapc IO.n	-	Υ	-	-					

7.10. BIT definition

Bit access of RAM is only available for address from 0x00 to 0x3F.



8. Code Options

Option	Selection	ection Description					
Coourity	Enable	OTP content is protected and program cannot be read back					
Security	Disable	OTP content is not protected so program can be read back					
	4.0V	Select LVR = 4.0V					
	3.5V	Select LVR = 3.5V					
	3.0V	Select LVR = 3.0V					
LVR	2.7V	Select LVR = 2.7V					
LVK	2.5V	Select LVR = 2.5V					
	2.2V	Select LVR = 2.2V					
	2.0V	Select LVR = 2.0V					
	1.8V	Select LVR = 1.8V					
Doot up Time	Slow	Please refer to t _{WUP} and t _{SBP} in Section 4.1					
Boot-up_Time	Fast	Please refer to t _{WUP} and t _{SBP} in Section 4.1					
Interrupt Croft	PA.0	INTEN/INTRQ.Bit0 is from PA.0					
Interrupt Src0	PB.5	INTEN/INTRQ.Bit0 is from PB.5					
Interrupt Cred	PB.0	INTEN/INTRQ.Bit1 is from PB.0					
Interrupt Src1	PA.4	INTEN/INTRQ.Bit1 is from PA.4					
	Disable	Comparator does not control all PWM outputs					
GPC_PWM	Enable	Comparator controls all PWM outputs					
		(ICE does NOT Support.)					
	16MHZ	When Pwmgclk.0= 1, PWMG clock source = IHRC = 16MHZ					
PWM_Source	2014117	When Pwmgclk.0= 1, PWMG clock source = IHRC*2 = 32MHZ					
	32MHZ	(ICE does NOT Support.)					
	16MHZ	When tm2c[7:4]= 0010, TM2 clock source = IHRC = 16MHZ					
TM2_Source		When tm2c[7:4]= 0010, TM2 clock source = IHRC*2 = 32MHZ					
	32MHZ	(ICE does NOT Support.)					
	6 Bit	When tm2s.7=1, TM2 PWM resolution is 6 Bit					
TM2_Bit	7 Bit	When tm2s.7=1, TM2 PWM resolution is 7 Bit					
	<i>i</i> Dil	(ICE does NOT Support.)					
	All_Edge	The comparator will trigger an interrupt on the rising edge or falling edge					
Comparator_Edge	Rising_Edge	The comparator will trigger an interrupt on the rising edge					
	Falling_Edge	The comparator will trigger an interrupt on the falling edge					



9. Special Notes

This chapter is to remind user who use PMS152 series IC in order to avoid frequent errors upon operation.

9.1. Warning

User must read all application notes of the IC by detail before using it. Please download the related application notes from the following link:

http://www.padauk.com.tw/tw/technical/index.aspx

9.2. Using IC

9.2.1. IO pin usage and setting

- (1) IO pin is set to be digital input
 - ◆ When IO is set as digital input, the level of Vih and Vil would changes with the voltage and temperature. Please follow the minimum value of Vih and the maximum value of Vil.
 - ◆ The value of internal pull high resistor would also changes with the voltage, temperature and pin voltage.
 It is not the fixed value.
- (2) IO pin as digital input and enable wakeup function
 - ◆ Configure IO pin as input
 - ◆ Set corresponding bit to "1" in PXDIER
 - ◆ For those IO pins of PA that are not used, PADIER[1:2] should be set low in order to prevent them from leakage.
- (3) PA5 is set to be output pin
 - ◆ PA5 can be set to be Open-Drain output pin only, output high requires adding pull-high resistor.
- (4) PA5 is set to be PRSTB input pin
 - ◆ Configure PA5 as input
 - ◆ Set CLKMD.0=1 to enable PA5 as PRSTB input pin
- (5) PA5 is set to be input pin and to connect with a push button or a switch by a long wire
 - \bullet Needs to put a >33Ω resistor in between PA5 and the long wire
 - ◆ Avoid using PA5 as input in such application.
- (6) PA7 and PA6 as external crystal oscillator
 - ◆ Configure PA7 and PA6 as input
 - ◆ Disable PA7 and PA6 internal pull-high resistor
 - ◆ Configure PADIER register to set PA6 and PA7 as analog input
 - ◆ EOSCR register bit [6:5] selects corresponding crystal oscillator frequency :
 - ♦ 01 : for lower frequency, ex : 32KHz
 - ♦ 10 : for middle frequency, ex : 455KHz, 1MHz
 - ♦ 11 : for higher frequency, ex : 4MHz
 - ◆ Program EOSCR.7 =1 to enable crystal oscillator
 - ◆ Ensure EOSC working well before switching from IHRC or ILRC to EOSC.



Note: Please read the PMC-APN013 carefully. According to PMC-APN013, the crystal oscillator should be used reasonably. If the following situations happen to cause IC start-up slowly or non-startup, PADAUK Technology is not responsible for this: the quality of the user's crystal oscillator is not good, the usage conditions are unreasonable, the PCB cleaner leakage current, or the PCB layouts are unreasonable.

9.2.2. Interrupt

(1) When using the interrupt function, the procedure should be:

Step1: Set INTEN register, enable the interrupt control bit

Step2: Clear INTRQ register

Step3: In the main program, using ENGINT to enable CPU interrupt function

Step4: Wait for interrupt. When interrupt occurs, enter to Interrupt Service Routine

Step5: After the Interrupt Service Routine being executed, return to the main program

*Use DISGINT in the main program to disable all interrupts

*When interrupt service routine starts, use PUSHAF instruction to save ALU and FLAG register.

POPAF instruction is to restore ALU and FLAG register before RETI as below:

(2) INTEN and INTRQ have no initial values. Please set required value before enabling interrupt function.

9.2.3. System clock switching

System clock can be switched by CLKMD register. Please notice that, NEVER switch the system clock and turn off the original clock source at the same time. For example: When switching from clock A to clock B, please switch to clock B first; and after that turn off the clock A oscillator through CLKMD.

```
◆ Example : Switch system clock from ILRC to IHRC/2
```

will be restored

```
CLKMD = 0x36; // switch to IHRC, ILRC can not be disabled here
CLKMD.2 = 0; // ILRC can be disabled at this time
```

♦ ERROR: Switch ILRC to IHRC and turn off ILRC simultaneously

CLKMD = 0x50; // MCU will hang

9.2.4. Watchdog

Watchdog will be inactive once ILRC is disabled.



9.2.5. TIMER time out

When select \$ INTEGS BIT_R (default value) and T16M counter BIT8 to generate interrupt, if T16M counts from 0, the first interrupt will occur when the counter reaches to 0x100 (BIT8 from 0 to 1) and the second interrupt will occur when the counter reaches 0x300 (BIT8 from 0 to 1). Therefore, selecting BIT8 as 1 to generate interrupt means that the interrupt occurs every 512 counts. Please notice that if T16M counter is restarted, the next interrupt will occur once Bit8 turns from 0 to 1.

If select \$ INTEGS BIT_F(BIT triggers from 1 to 0) and T16M counter BIT8 to generate interrupt, the T16M counter changes to an interrupt every 0x200/0x400/0x600/. Please pay attention to two differences with setting INTEGS methods.

9.2.6. IHRC

- (1) The IHRC frequency calibration is performed when IC is programmed by the writer.
- (2) Because the characteristic of the Epoxy Molding Compound (EMC) would some degrees affects the IHRC frequency (either for package or COB), if the calibration is done before molding process, the actual IHRC frequency after molding may be deviated or becomes out of spec. Normally, the frequency is getting slower a bit.
- (3) It usually happens in COB package or Quick Turnover Programming (QTP). And PADAUK would not take any responsibility for this situation.
- (4) Users can make some compensatory adjustments according to their own experiences. For example, users can set IHRC frequency to be 0.5% ~ 1% higher and aim to get better re-targeting after molding.

9.2.7. LVR

User can set *MISC.2* as "1" to disable LVR. However, V_{DD} must be kept as exceeding the lowest working voltage of chip; Otherwise IC may work abnormally.

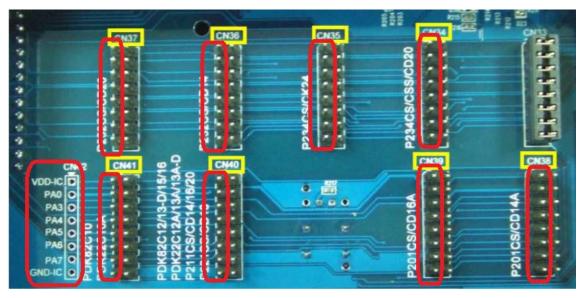
9.2.8. Programming Writing

There are 6 pins for using the writer to program: PA3, PA4, PA5, PA6, VDD and GND.

If use PDK3S-P-002 to program PMS152 real chip, just use the CN39 jumper (at the back for the writer) with putting the 16pin package IC on the top of the Textool. For the 14pin package, it need downward one space on the Textool, for the 10pin package, it need downward three spaces on the Textool, and for the 8pin package, it need downward four spaces on the Textool.

Other packages could be programmed by connecting the signals correspondingly. All the signals of the left side of the jumpers are the same and as the descriptions at the left bottom corner. They are VDD, PA0(not used), PA3, PA4, PA5, PA6, PA7(not used), and GND).





If user use PDK5S-P-003 or above to program, please follow the instructions for connecting jumpers.

- Special notes about voltage and current while Multi-Chip-Package(MCP) or On-Board Programming
- (1) PA5 (V_{PP}) may be higher than 11 V.
- (2) V_{DD} may be higher than 6.5V, and its maximum current may reach about 20mA.
- (3) All other signal pins level (except GND) are the same as V_{DD}.

User should confirm when using this product in MCP or On-Board Programming, the peripheral components or circuit will not be damaged by the above voltages, and will not clam the above voltages.

Important Cautions:

- You MUST follow the instructions on APN004 and APN011 for programming IC on the handler.
- Connecting a 0.01uF capacitor between VDD and GND at the handler port to the IC is always good for suppressing disturbance. But please DO NOT connect with > 0.01uF capacitor, otherwise, programming may be fail.



9.3. Using ICE

PDK5S-I-S01/2 (B) supports PMS152 1-FPPA MCU emulation work, the following items should be noted when using PDK5S-I-S01/2(B) to emulate PMS152:

- PDK5S-I-S01/2(B) doesn't support the function of the set of 11-bit SuLED hardware PWM generators.
- PDK5S-I-S01/2(B) doesn't support the instruction NADD/COMP of PMS152.
- PDK5S-I-S01/2 (B) doesn't support SYSCLK=ILRC/16 of PMS152.
- PDK5S-I-S01/2 (B) doesn't support the function *Tm2.gpcrs* of PMS152.
- The PA3 output function will be affected when GPCS selects output to PA0 output.
- When simulating PWM waveform, please check the waveform during program running. When the ICE is suspended or single-step running, its waveform may be inconsistent with the reality.
- The ILRC frequency of the PDK5S-I-S01/2(B) simulator is different from the actual IC and is uncalibrated, with a frequency range of about 34K~38KHz.
- Fast Wakeup time is different from PDK5S-I-S01/2(B): 128 SysClk, PMS152: 45 ILRC.
- Watch dog time out period is different from PDK5S-I-S01/2:

WDT period	PDK5S-I-S01/2(B)	PMS152		
misc[1:0]=00	2048 * T _{ILRC}	8192 * T _{ILRC}		
misc[1:0]=01	4096 * T _{ILRC}	16384 * T _{ILRC}		
misc[1:0]=10	16384 * T _{ILRC}	65536 * T _{ILRC}		
misc[1:0]=11	256 * T _{ILRC}	262144 * T _{ILRC}		